TEXAS INSTRUMENTS
TUSB8044
JAJSD86 – APRIL 2017

TUSB8044 4ポートUSB 3.1 Gen1ハブ、USB Billboard付き

1 特長

- 4ポートのUSB 3.1 Gen1ハブ
- USB 2.0ハブ機能
  - Multiple Transaction Translator (MTT)ハブ：4つのトランザクション・トランスレータ
  - トランザクション・トレンスレータごとに2つの非同期エンドポイント・バッファ
- サポートされるバッテリ充電
  - 上流ポートの未接続または未構成時に、D+/D-デバイダ充電ポート(ACP1、ACP2、ACP3)をサポート
  - 上流ポートの未接続時に、DCPまたはACPモードの自動移行モードをサポート
  - Galaxy充電をサポート
  - CDPモード(上流ポート接続時)
  - DCPモード(上流ポート未接続時)
  - DCPモードは中国電気通信業界標準YD/T 1591-2009に準拠
- USB 3.1 Gen1またはUSB 2.0複合デバイスとしての動作をサポート
- USB Billboardをサポート
- ポート単位または一括制御のパワー・スイッチング、過電流通知入力
- 4つの外部下流ポートと内部USB 2.0専用ポートで、USB HID to I^{2}C機能およびUSB2.0 Billboardをサポート
- USB HIDを介したI^{2}C制御用の内部下流ポートで、ハイ・スピードおよびフル・スピード動作をサポートし、上流ポートに対応するスピードを提供
- I^{2}Cの読み出し/書き込みと、100kおよび400k (デフォルト)でのEEPROMの読み出しに対するベンダー要求をサポート
- I^{2}Cマスタでクロック・ストレッチングをサポート
- OTP ROM、シリアルEEPROM、またはI^{2}C/SMBusスレーブ・インターフェイスで次のカスタム構成をサポート
  - VIDおよびPID
  - ポートのカスタマイズ
  - メーカーおよび製品文字列(OTP ROMは除く)
  - シリアル番号(OTP ROMは除く)
- 128ビットのUniversally Unique Identifier (UUID)を提供
- USB 2.0上流ポート経由でオンボードおよびイン・システムのEEPROMプログラミングをサポート
- 単一クロック入力、24MHzクリスタルまたはオシレータ
- 下流ポートはUSB 2.0の構成のみ
- 64ピンQFNパッケージ(RGC)

2 アプリケーション

コンピュータ・システム、ドッキング・ステーション、モニタ、セットトップ・ボックス

3 概要

TUSB8044は4ポートのUSB 3.1 Gen1ハブです。上流ポートでスーパー・スピードUSBおよびハイ・スピード/フル・スピード接続を同時に提供し、下流ポートでスーパー・スピードUSB、ハイ・スピード、フル・スピード、ロー・スピード接続を提供します。ハイ・スピード、フル・スピード、ロー・スピード接続のみをサポートする電子環境に上流ポートが接続されている場合、スーパー・スピードUSB接続は下流ポートで無効化されます。

製品情報(1)

型番	パッケージ	本体サイズ(公称)
TUSB8044	VQFN (64)	9.00mm×9.00mm

(1) 利用可能なすべてのパッケージについては、このデータシートの末尾にある注文情報を参照してください。

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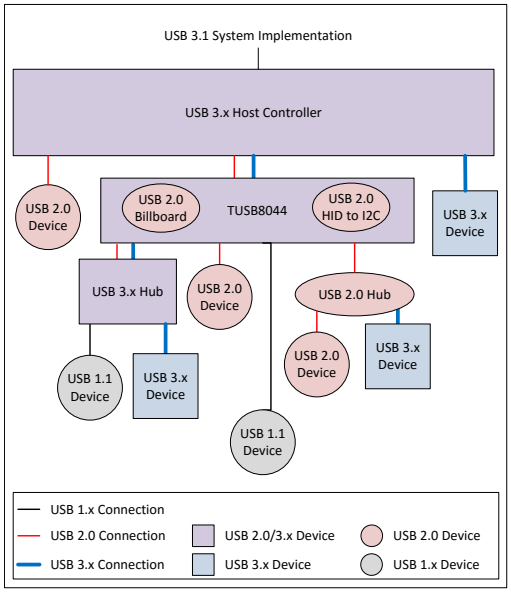


目次

4 改訂履歴

日付	改訂内容	注
2017年4月	*	暫定版リリース

5 概要(続き)

フル・スピード、ロー・スピード接続のみをサポートする電子環境に上流ポートが接続されている場合、スーパー・スピードUSBおよびハイ・スピード接続は下流ポートで無効化されます。

TUSB8044は、ポート別または一括制御のパワー・スイッチングと過電流保護を提供し、バッテリ充電アプリケーションをサポートします。

ポート別電力制御のハブでは、USBホストからの要求に応じて各下流ポートへの電力がオン/オフされます。また、過電流を検出した場合には、影響を受ける下流ポートへの電力だけがオフになります。

一括制御のハブでは、いずれかのポートで電力が必要になると、すべての下流ポートへの給電をオンにします。下流ポートへの給電は、すべてのポートが給電を停止できる状態にならない限り、オフになりません。また、一括制御のハブが過電流イベントを検出すると、すべての下流ポートへの給電がオフになります。

TUSB8044の下流ポートは、Battery Charging Downstream Port (CDP)ハンドシェイクに対応することで、バッテリ充電アプリケーションにサポートを提供します。また、上流ポートの未接続時にDedicated Charging Port (DCP)をサポートします。DCPモードは、USBバッテリ充電、Galaxy充電、中国電気通信業界標準YD/T 1591-2009をサポートするUSBデバイスに対応します。 上流ポートの未接続時、TUSB8044はさらに、デバイダ充電ポート・モード(ACPxモード)と、ACP3からDCPまでの全モード間の自動移行をサポートします。

TUSB8044に内蔵されたUSB2.0 Billboardデバイスは、「USB Device Class Definition for Billboard Devices Version 1.1」仕様をサポートします。Billboardデバイスは、TUSB8044 USB 2.0ハブの下流ポートのうち最も数字の大きいポートに接続されます。Billboardの目的は、Alternateモードのステータスをホスト・システムに伝えることです。TUSB8044がサポートするAlternateモードは1つだけです。

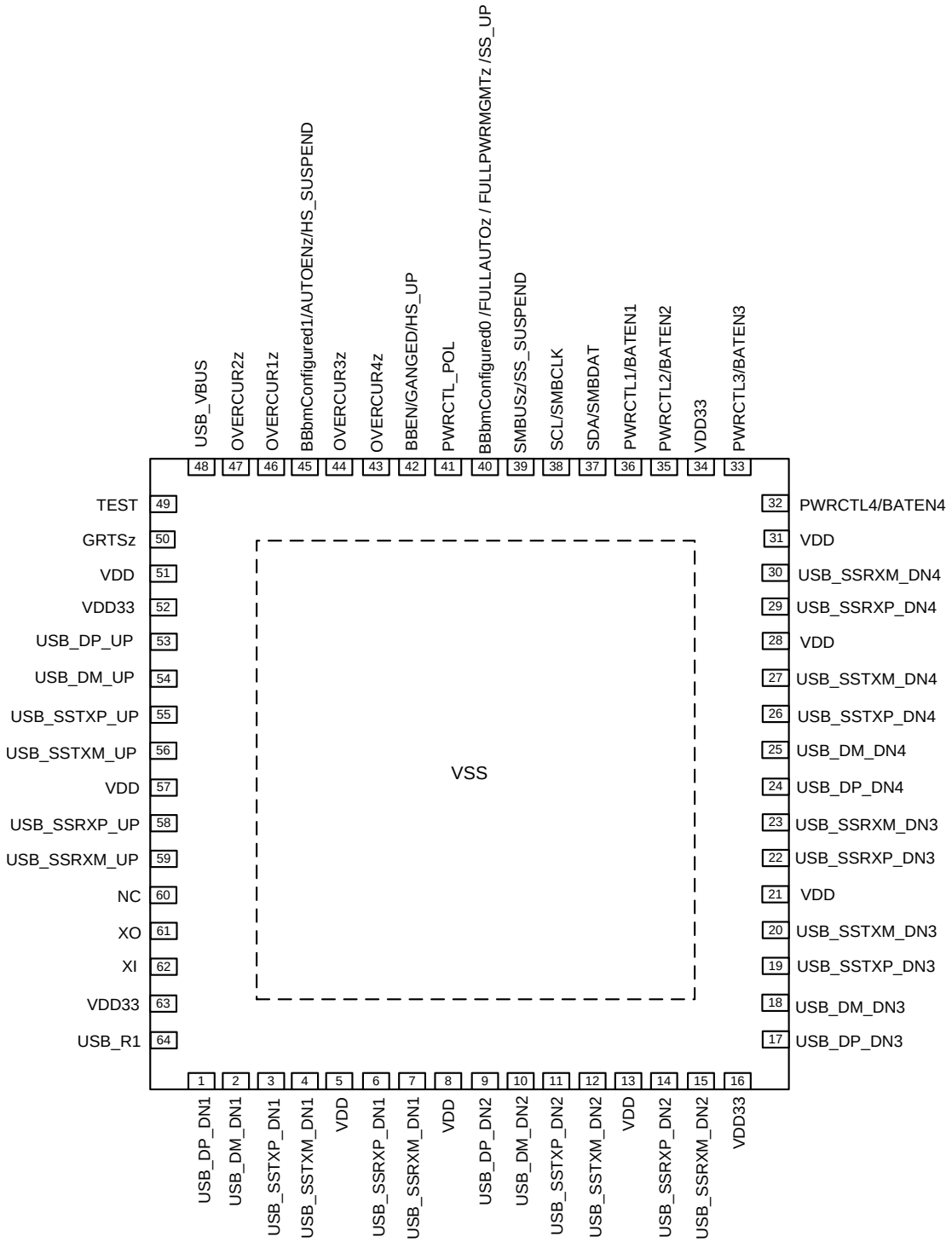
TUSB8044は、バッテリ充電サポートなどの機能のためにピン・ストラップ構成を提供しており、OTP ROM、I^2C EEPROM、またはI^2C/SMBusスレーブ・インターフェイスを介した、PID、VID、カスタム・ポート、PHY構成のカスタマイズをサポートしています。また、I^2C EEPROMまたはI^2C/SMBusスレーブ・インターフェイスを使用する場合、カスタム文字列をサポートします。

TUSB8044は、内部USB HIDからI^2Cへのインターフェイスを介して、接続先のEEPROMのプログラミングをサポートします。

このデバイスは64ピンRGCパッケージで提供されます。0℃～70℃の温度範囲での動作向けには商用バージョンで提供されます。

6 Pin Configuration and Functions

RGC Package
64 Pin (VQFN)
(Top View)



Pin Functions

PIN		I/O	DESCRIPTION
NAME	NO.		
Clock and Reset Signals			
GRSTz	50	I PU	Global power reset. This reset brings all of the TUSB8044 internal registers to their default states. When GRSTz is asserted, the device is completely nonfunctional.
XI	62	I	Crystal input. This pin is the crystal input for the internal oscillator. The input may alternately be driven by the output of an external oscillator. When using a crystal a 1-MΩ feedback resistor is required between XI and XO.
XO	61	O	Crystal output. This pin is the crystal output for the internal oscillator. If XI is driven by an external oscillator this pin may be left unconnected. When using a crystal a 1-MΩ feedback resistor is required between XI and XO.
USB Upstream Signals			
USB_SSTXP_UP	55	O	USB SuperSpeed transmitter differential pair (positive)
USB_SSTXM_UP	56	O	USB SuperSpeed transmitter differential pair (negative)
USB_SSRXP_UP	58	I	USB SuperSpeed receiver differential pair (positive)
USB_SSRXM_UP	59	I	USB SuperSpeed receiver differential pair (negative)
USB_DP_UP	53	I/O	USB High-speed differential transceiver (positive)
USB_DM_UP	54	I/O	USB High-speed differential transceiver (negative)
USB_R1	64	I	Precision resistor reference. A 9.53-kΩ ±1% resistor should be connected between USB_R1 and GND.
USB_VBUS	48	I	USB upstream port power monitor. The VBUS detection requires a voltage divider. The signal USB_VBUS must be connected to VBUS through a 90.9-KΩ ±1% resistor, and to ground through a 10-kΩ ±1% resistor from the signal to ground.
USB Downstream Signals			
USB_SSTXP_DN1	3	O	USB SuperSpeed transmitter differential pair (positive)
USB_SSTXM_DN1	4	O	USB SuperSpeed transmitter differential pair (negative)
USB_SSRXP_DN1	6	I	USB SuperSpeed receiver differential pair (positive)
USB_SSRXM_DN1	7	I	USB SuperSpeed receiver differential pair (negative)
USB_DP_DN1	1	I/O	USB High-speed differential transceiver (positive)
USB_DM_DN1	2	I/O	USB High-speed differential transceiver (negative)
PWRCTL1/BATEN1	36	I/O, PD	USB Port 1 Power On Control for Downstream Power/Battery Charging Enable. The pin is used for control of the downstream power switch for Port 1. This pin be left unconnected if power management is not implemented. In addition, the value of the pin is sampled at the de-assertion of reset to determine the value of the battery charging support for Port 1 as indicated in the Battery Charging Support register: 0 = Battery charging not supported 1 = Battery charging supported
OVERCUR1z	46	I, PU	USB Port 1 Over-Current Detection. This pin is typically connected to the over current output of the downstream port power switch for Port 1. 0 = An over current event has occurred 1 = An over current event has not occurred When GANGED power management is enabled, this pin or one of the other OVERCURz pins must be connected to the over current output of the power switch or circuit which detects the over current conditions. For the case when another OVERCURz pin is used, this pin can be left unconnected.
USB_SSTXP_DN2	11	O	USB SuperSpeed transmitter differential pair (positive)
USB_SSTXM_DN2	12	O	USB SuperSpeed transmitter differential pair (negative)
USB_SSRXP_DN2	14	I	USB SuperSpeed receiver differential pair (positive)
USB_SSRXM_DN2	15	I	USB SuperSpeed receiver differential pair (negative)
USB_DP_DN2	9	I/O	USB High-speed differential transceiver (positive)
USB_DM_DN2	10	I/O	USB High-speed differential transceiver (negative)

Pin Functions (continued)

PIN		I/O	DESCRIPTION
NAME	NO.		
PWRCTL2/BATEN2	35	I/O, PD	USB Port 2 Power On Control for Downstream Power/Battery Charging Enable. The pin is used for control of the downstream power switch for Port 2. This pin be left unconnected if power management is not implemented. In addition, the value of the pin is sampled at the de-assertion of reset to determine the value of the battery charging support for Port 2 as indicated in the Battery Charging Support register: 0 = Battery charging not supported 1 = Battery charging supported
OVERCUR2z	47	I, PU	USB Port 2 Over-Current Detection. This pin is typically connected to the over current output of the downstream port power switch for Port 2. 0 = An over current event has occurred 1 = An over current event has not occurred When GANGED power management is enabled, this pin or one of the other OVERCURz pins must be connected to the over current output of the power switch or circuit which detects the over current conditions. For the case when another OVERCURz pin is used, this pin can be left unconnected.
USB_SSTXP_DN3	19	O	USB SuperSpeed transmitter differential pair (positive)
USB_SSTXM_DN3	20	O	USB SuperSpeed transmitter differential pair (negative)
USB_SSRXP_DN3	22	I	USB SuperSpeed receiver differential pair (positive)
USB_SSRXM_DN3	23	I	USB SuperSpeed receiver differential pair (negative)
USB_DP_DN3	17	I/O	USB High-speed differential transceiver (positive)
USB_DM_DN3	18	I/O	USB High-speed differential transceiver (negative)
PWRCTL3/BATEN3	33	I/O, PD	USB Port 3 Power On Control for Downstream Power/Battery Charging Enable. The pin is used for control of the downstream power switch for Port 3. This pin be left unconnected if power management is not implemented. In addition, the value of the pin is sampled at the de-assertion of reset to determine the value of the battery charging support for Port 3 as indicated in the Battery Charging Support register: 0 = Battery charging not supported 1 = Battery charging supported
OVERCUR3z	44	I, PU	USB Port 3 Over-Current Detection. This pin is typically connected to the over current output of the downstream port power switch for Port 3. 0 = An over current event has occurred 1 = An over current event has not occurred When GANGED power management is enabled, this pin or one of the other OVERCURz pins must be connected to the over current output of the power switch or circuit which detects the over current conditions. For the case when another OVERCURz pin is used, this pin can be left unconnected.
USB_SSTXP_DN4	26	O	USB SuperSpeed transmitter differential pair (positive)
USB_SSTXM_DN4	27	O	USB SuperSpeed transmitter differential pair (negative)
USB_SSRXP_DN4	29	I	USB SuperSpeed receiver differential pair (positive)
USB_SSRXM_DN4	30	I	USB SuperSpeed receiver differential pair (negative)
USB_DP_DN4	24	I/O	USB High-speed differential transceiver (positive)
USB_DM_DN4	25	I/O	USB High-speed differential transceiver (negative)
PWRCTL4/BATEN4	32	I/O, PD	USB Port 4 Power On Control for Downstream Power/Battery Charging Enable. The pin is used for control of the downstream power switch for Port 4. This pin be left unconnected if power management is not implemented. In addition, the value of the pin is sampled at the de-assertion of reset to determine the value of the battery charging support for Port 4 as indicated in the Battery Charging Support register: 0 = Battery charging not supported 1 = Battery charging supported

Pin Functions (continued)

PIN		I/O	DESCRIPTION
NAME	NO.		
OVERCUR4z	43	I, PU	USB Port 4 Over-Current Detection. This pin is typically connected to the over current output of the downstream port power switch for Port 4. 0 = An over current event has occurred 1 = An over current event has not occurred When GANGED power management is enabled, this pin or one of the other OVERCURz pins must be connected to the over current output of the power switch or circuit which detects the over current conditions. For the case when another OVERCURz pin is used, this pin can be left unconnected.
I²C/SMBUS I²C Signals			
SCL/SMBCLK	38	I/O, PD	I²C clock/SMBus clock. Function of pin depends on the setting of the SMBUSz input. When SMBUSz = 1, this pin acts as the serial clock interface for an I²C EEPROM. When SMBUSz = 0, this pin acts as the serial clock interface for an SMBus host. Can be left unconnected if external interface not implemented.
SDA/SMBDAT	37	I/O, PD	I²C data/SMBus data. Function of pin depends on the setting of the SMBUSz input. When SMBUSz = 1, this pin acts as the serial data interface for an I²C EEPROM. When SMBUSz = 0, this pin acts as the serial data interface for an SMBus host. Can be left unconnected if external interface not implemented.
SMBUSz/SS_SUSPEND	39	I/O, PU	I²C/SMBus mode select/SuperSpeed USB Suspend Status. The value of the pin is sampled at the de-assertion of reset set I²C or SMBus mode as follows: 1 = I²C Mode Selected 0 = SMBus Mode Selected Can be left unconnected if external interface not implemented. After reset, this signal indicates the SuperSpeed USB Suspend status of the upstream port if enabled through the stsOutputEn bit in the Additional Feature Configuration register. When enabled, a value of 1 indicates the connection is suspended.
Test and Miscellaneous Signals			
PWRCTL_POL	41	I/O, PU	Power Control Polarity. The value of the pin is sampled at the de-assertion of reset to set the polarity of PWRCTL[4:1]. 0 = PWRCTL polarity is active low 1 = PWRCTL polarity is active high
BBEN/GANGED/HS_UP	42	I/O, PD	When configured for I2C mode, this pin functions as Billboard Enable. When high, the billboard device is enabled and presented to system. When low, the billboard device is disabled. If SMBus is selected, then Billboard enable is controlled by a register. If SMBus is selected and stsOutputEn bit is set, this pin will function as a HS_UP (upstream HS connection indicator). When enabled, a value of 1 indicates the upstream port is connected to a High-speed USB capable port. If SMBus is selected, the value of the pin is sampled at the de-assertion of reset to set the power switch and over current detection mode as follows: 0= Individual port power control supported. 1= Ganged port Power control supported. SMBus master can at a later time override the register.
BBbmConfigured0 /FULLAUTOz / FULLPWRMGMTz /SS_UP	40	I/O, PD	When configured for I2C mode, this pin along with BBbmConfigured1 directly controls the bmConfigurated field in the Billboard Capability descriptor. If SMBus is selected, then bmConfigured[0] field is determined by a register. If SMBus is selected and battery charginig is enabled on any port, the sampled state of this pin will set or clear the FullAutoEn bit in the Device Configuration Register 3. SMBus master can at a later time override the register. If SMBus is selected and battery charging is disabled, then the value of the pin is sampled at the de-assertion of reset to set the power switch control: SMBus master can at a later time override this function. 0 = Power Switching and over current inputs supported. 1= Power Switch and over current inputs not supported. If SMBus is selected and stsOutputEn bit is set, ths pin will function as a SS_UP (upstream SS connection indicator). When enabled, a value of 1 indicates the upstream port is connected to a SuperSpeed USB capable port.

Pin Functions (continued)

PIN		I/O	DESCRIPTION
NAME	NO.		
BBbmConfigured1/AUTOENz/HS_SUSPEND	45	I/O, PD	When configured for I2C mode, this pin along with BBbmConfigured0 directly controls the bmConfigurated field in the Billboard Capability descriptor. If SMBus is selected, then bmConfigured[1] field is determined by a register. If SMBus is selected, the sampled value of this pin will set or clear the autoEnz bit in the Battery Charging Support Register. SMBus master can at a later time override the register. If SMBus is selected and stsOutputEn bit is set, this pin will function as a HS_SUSPEND (upstream HS suspend indicator). When enabled, a value of 1 indicates the connection is suspended.
TEST	49	I, PD	This pin is reserved for factory test. It is suggested to have this pin pulled down to ground on PCB.
Power and Ground Signals			
VDD	5, 8, 13, 21, 28, 31, 51, 57	PWR	1.1-V power rail
VDD33	16, 34, 52, 63	PWR	3.3-V power rail
VSS (Thermal Pad)		PWR	Ground. Thermal pad must be connected to ground.
NC	60	—	No connect, leave floating

7 Specifications

7.1 Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

		MIN	MAX	UNIT
Supply Voltage Range	V_{DD} Steady-state supply voltage	–0.3	1.4	V
	V_{DD33} Steady-state supply voltage	–0.3	3.8	V
Voltage Range	USB_SSRXP_UP, USB_SSRXN_UP, USB_SSRXP_DN[4:1], USB_SSRXN_DP[4:1] and USB_VBUS terminals	-0.3	1.4	V
	XI terminals	-0.3	2.45	V
	All other terminals	-0.3	3.8	V
Storage temperature, T_{stg}		–65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

			VALUE	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001(1)	±2000	V
		Charged device model (CDM), per JEDEC specification JESD22-C101(2)	±500	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

			MIN	NOM	MAX	UNIT
VDD(1)	1.1V supply voltage		0.99	1.1	1.26	V
VDD33	3.3V supply voltage		3	3.3	3.6	V
USB_VBUS	Voltage at USB_VBUS PAD		0		1.155	V
T_A	Operating free-air temperature	TUSB8044	0		70	°C
T_J	Operating junction temperature		–40		105	°C

(1) A 1.05-V, 1.1-V, or 1.2-V supply may be used as long as minimum and maximum supply conditions are met.

7.4 Thermal Information

THERMAL METRIC(1)		TUSB8044 RGC 64 PINS	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	26	°C/W
$R_{\theta JCtop}$	Junction-to-case (top) thermal resistance	11.5	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	5.3	°C/W
ψ_{JT}	Junction-to-top characterization parameter	0.2	°C/W
ψ_{JB}	Junction-to-board characterization parameter	5.2	°C/W
$R_{\theta JCbot}$	Junction-to-case (bottom) thermal resistance	1.0	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report.

7.5 Electrical Characteristics, 3.3-V I/O

over operating free-air temperature range (unless otherwise noted)

PARAMETER		OPERATION	TEST CONDITIONS	MIN	TYP	MAX	UNIT
V_{IH}	High-level input voltage(1)	VDD33		2		VDD33	V
V_{IL}	Low-level input voltage(1)	VDD33		0		0.8	V
V_I	Input voltage			0		VDD33	V
V_O	Output voltage(2)			0		VDD33	V
t_t	Input transition time (t_{rise} and t_{fall})			0		25	ns
V_{hys}	Input hysteresis(3)					0.13 x VDD33	V
V_{OH}	High-level output voltage	VDD33	I_{OH} = -4 mA	2.4			V
V_{OL}	Low-level output voltage	VDD33	I_{OL} = 4 mA			0.4	V
I_{OZ}	High-impedance, output current(2)	VDD33	V_I = 0 to VDD33			±20	µA
I_{OZP}	High-impedance, output current with internal pullup or pulldown resistor(4)	VDD33	V_I = 0 to VDD33			±250	µA
I_I	Input current(5)	VDD33	V_I = 0 to VDD33			±15	µA
R_{PD}	Internal pull-down resister			13.5	19	27.5	KΩ
R_{PU}	Internal pull-up resistor			14.5	19	25	KΩ

(1) Applies to external inputs and bidirectional buffers.
(2) Applies to external outputs and bidirectional buffers.
(3) Applies to GRSTz.
(4) Applies to pins with internal pullups/pulldowns.
(5) Applies to external input buffers.

7.6 Timing Requirements, Power-Up

PARAMETER	DESCRIPTION	MIN	TYP	MAX	UNIT
t_{d1}	VDD33 stable before VDD stable(1)	See (2)			ms
t_{d2}	VDD and VDD33 stable before de-assertion of GRSTz	3			ms
t_{su_io}	Setup for MISC inputs(3) sampled at the de-assertion of GRSTz	0.1			µs
t_{hd_io}	Hold for MISC inputs(3) sampled at the de-assertion of GRSTz	0.1			µs
t_{VDD33_RAMP}	VDD33 supply ramp requirements	0.2		100	ms
t_{VDD_RAMP}	VDD supply ramp requirements	0.2		100	ms

(1) An active reset is required if the VDD33 supply is stable before the VDD11 supply. This active Reset shall meet the 3ms power-up delay counting from both power supplies being stable to the de-assertion of GRSTz.
(2) There is no power-on relationship between VDD33 and VDD unless GRSTz is only connected to a capacitor to GND. Then VDD must be stable minimum of 10 µs before the VDD33.
(3) MISC pins sampled at de-assertion of GRSTz: BATEN[4:1], SMBUSz, and PWRCTL_POL.

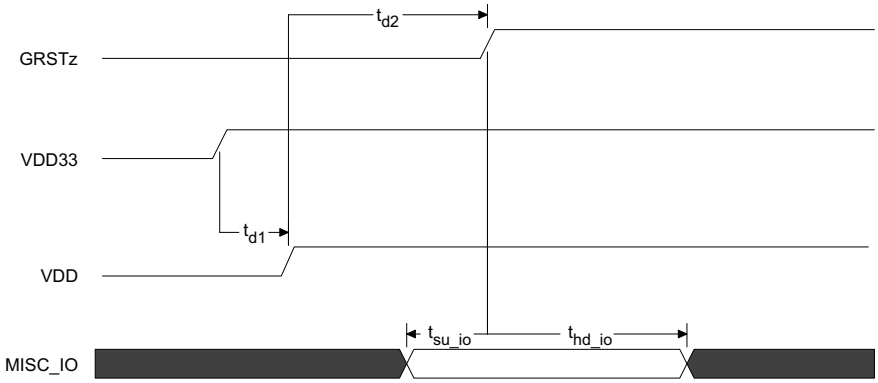


Figure 1. Power-Up Timing Requirements

7.7 Hub Input Supply Current

Typical values measured at T_A = 25°C

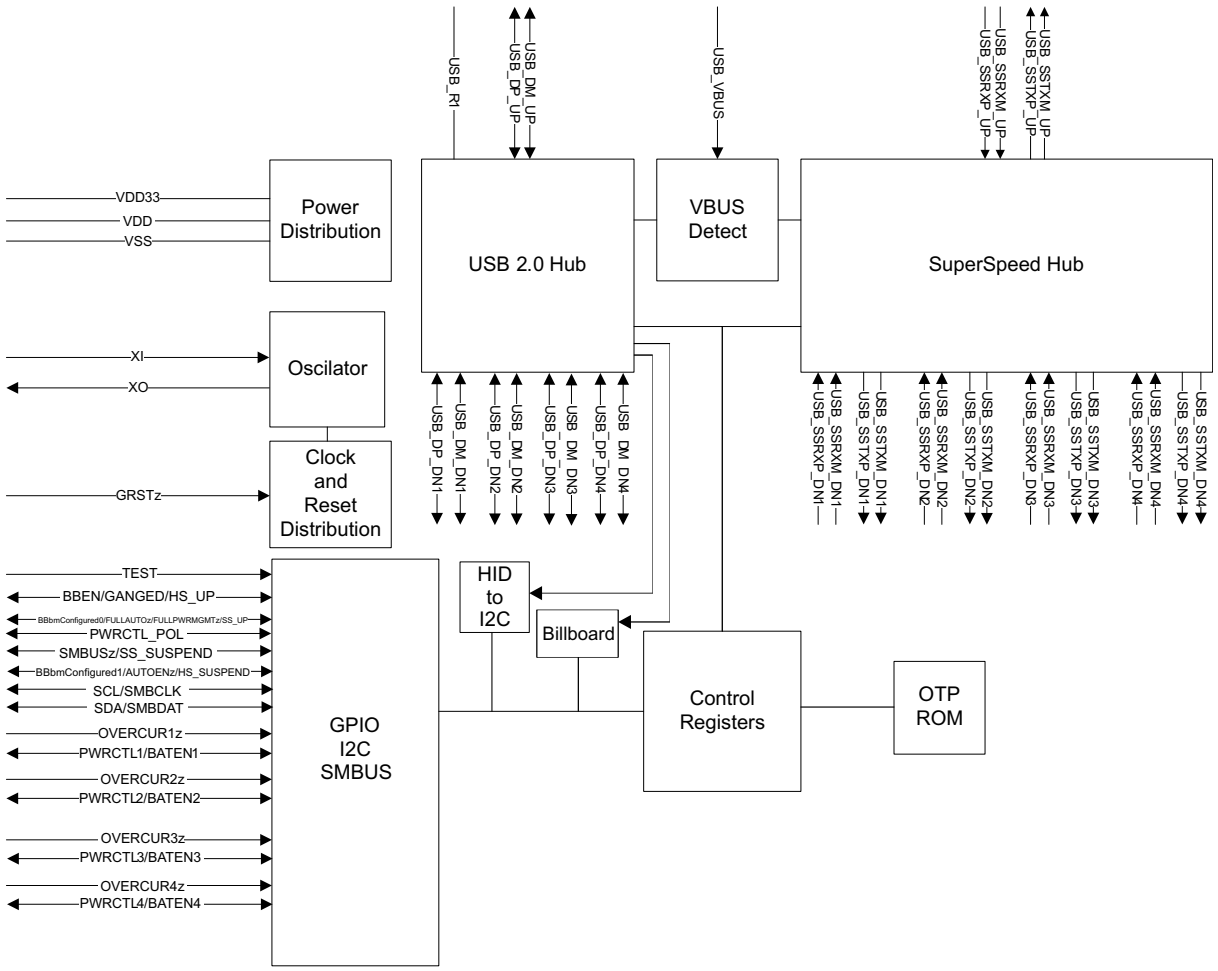
PARAMETER	VDD33	VDD	UNIT
	3.3 V	1.1 V	
LOW POWER MODES			
Power On (after Reset)	3	30	mA
Upstream Disconnect	3	24	mA
Suspend	3	30	mA
ACTIVE MODES (US state / DS State)			
3.0 host / 1 SS Device and Hub in U1 / U2	45	240	mA
3.0 host / 1 SS Device and Hub in U0	45	356	mA
3.0 host / 2 SS Devices and Hub in U1 / U2	45	301	mA
3.0 host / 2 SS Devices and Hub in U0	45	457	mA
3.0 host / 3 SS Devices and Hub in U1 / U2	45	372	mA
3.0 host / 3 SS Devices and Hub in U0	45	563	mA
3.0 host / 4 SS Devices and Hub in U1 / U2	45	440	mA
3.0 host / 4 SS Devices and Hub in U0	45	672	mA
3.0 host / 4 SS Devices and Hub in U0 plus Billboard enabled	45	680	mA
3.0 host / 1 SS Device in U0 and 1 HS Device	84	372	mA
3.0 host / 2 SS Devices in U0 and 2 HS Devices	95	512	mA
2.0 host / HS Device	45	55	mA
2.0 host / 4 HS Devices	76	74	mA
2.0 host / 4 HS Devices plus Billboard enabled.	76	76	mA

8 Detailed Description

8.1 Overview

The TUSB8044 is a four-port USB 3.1 Gen1 compliant hub. It provides simultaneous SuperSpeed USB and high-speed/full-speed connections on the upstream port and provides SuperSpeed USB, high-speed, full-speed, or low-speed connections on the downstream ports. When the upstream port is connected to an electrical environment that only supports high-speed or full-speed/low-speed connections, SuperSpeed USB connectivity is disabled on the downstream ports. When the upstream port is connected to an electrical environment that only supports full-speed/low-speed connections, SuperSpeed USB and high-speed connectivity are disabled on the downstream ports.

8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 Battery Charging Features

The TUSB8044 provides support for USB Battery Charging (BC1.2) and custom charging. Battery charging support may be enabled on a per port basis through the REG_6h(batEn[3:0]).

USB Battery charging support includes both Charging Downstream Port (CDP) and Dedicated Charging Port (DCP) modes. The DCP mode is compliant with the Chinese Telecommunications Industry Standard YD/T 1591-2009. CDP is enabled when the upstream port has detected valid VBUS, configured, and host sets port power. When the upstream port is not connected and battery charging support is enabled, the TUSB8044 will enable DCP mode.

In addition to USB Battery charging (BC1.2), the TUSB8044 supports custom charging indications: Divider Charging (ACP3, ACP2, ACP1 modes), and Galaxy compatible charging. These custom charging modes are only supported when upstream port is unconnected and AUTOMODE is enabled. When in AUTOMODE and upstream port is disconnected, the port will automatically transition from ACP mode to the DCP mode depending on the portable device connected. The divided mode places a fixed DC voltage on the ports DP and DM signals which allows some devices to identify the capabilities of the charger. The default divider mode indicates support for up to 10W (ACP3). The divider mode can be configured to report a lower-current setting (up to 5 W) through REG_0Ah (HiCurAcpModeEn).

When the upstream port is not connected and battery charging support is enabled for a port, the TUSB8044 drives the port power enable active. If AUTOMODE is disabled, then DCP mode is used. If AUTOMODE is enabled and FullAutoEn bit is cleared (Reg_25h Bit 0), then TUSB8044 will start with highest enabled divider current mode (ACPx). The TUSB8044 will remain in highest current mode as long as a pull-up is not detected on DP pin. If an pull-up is detected on DP pin, then TUSB8044 will drive the port power enable inactive and switch to Galaxy mode, if enabled, or to DCP mode if Galaxy mode is disabled. The TUSB8044 will again drive the port power enable active. The TUSB8044 will remain in Galaxy mode as long as no pull-up is detected on DP pin. If an pull-up is detected on DP pin, then TUSB8044 will drive the port power enable inactive and transition to DCP mode. The TUSB8044 will again drive the port power enable active. In DCP mode, the TUSB8044 will look for a pull-up detected on DP pin or RxVdat. If a pull-up or RxVdat is detected on DP, the TUSB8044 will remain in DCP mode. If no pull-up or RxVdat is detected on DP pin after 2 seconds, the TUSB8044 will drive the port power enable inactive and transition back to ACPx mode. This sequence will repeat until upstream port is connected.

When Automatic mode is enabled and full automatic mode (FullAutoEn Reg_25h bit 0) is enabled, TUSB8044 will perform same sequence described in previous paragraph with the addition of attempting all supported ACPx modes before sequencing to Galaxy Mode (if enabled) or DCP mode.

The supported battery charging modes when TUSB8044 configured for SMBus or external EEPROM is detailed in Battery Charging Modes with SMBus/EEPROM Table.

The supported battery charging modes when TUSB8044 configured for I2C but without an external EEPROM is determined by the sampled state of the pins. These modes are detailed in Battery Charging Modes without EEPROM Table.

Feature Description (continued)

Table 1. TUSB8044 Battery Charging Modes with SMBus or I2C EEPROM

batEn[n] Reg_06h Bits 3:0	Upstream VBUS	HiCurAcpMode En Reg_0Ah Bit 4	autoModeEnz Reg_0Ah Bit 1	FullAutoEn Reg_25h Bit 0	Galaxy_Enz Reg_25h Bit 1	Battery Charging Mode Port x (x = n + 1)
0	Don't Care	Don't Care	Don't Care	Don't Care	Don't Care	No Charging support
1	> 4V	Don't Care	Don't Care	Don't Care	Don't Care	CDP
1	< 4V	Don't Care	1	Don't Care	Don't Care	DCP
1	< 4V	0	0	1	1	AUTOMODE enabled. Sequences through all ACPx modes and DCP with the exception of ACP3 Alternate ACP2, ACP1, DCP
1	< 4V	1	0	1	1	AUTOMODE enabled. Sequences through all ACPx modes and DCP. Alternate ACP3, ACP2, ACP1, DCP
1	< 4 V	0	0	0	1	AUTOMODE enabled. Sequences between ACP2 and DCP. Alternate ACP2, DCP
1	< 4V	1	0	0	1	AUTOMODE enabled. Sequences between ACP3 and DCP. Alternate ACP3, DCP
1	< 4V	0	0	1	0	AUTOMODE enabled with Galaxy compatible charging support. Alternate ACP2, ACP1, Galaxy, DCP.
1	< 4V	1	0	1	0	AUTOMODE enabled with Galaxy compatible charging support. Alternate ACP3, ACP2, ACP1, Galaxy, DCP
1	< 4V	0	0	0	0	AUTOMODE enabled with Galaxy compatible charging support. Alternate ACP2, Galaxy, DCP
1	< 4V	1	0	0	0	AUTOMODE enabled with Galaxy compatible charging support. Alternate ACP3, Galaxy, DCP

Table 2. TUSB8044 Battery Charging Modes I2C Mode without EEPROM

BATEN[3:0] pins	Upstream VBUS	Galaxy_Enz OTP	Battery Charging Mode Port x (x = n + 1)
0	Don't Care	Don't Care	No Charging support
1	> 4V	Don't Care	CDP
1	< 4V	0	AUTOMODE enabled with Galaxy compatible charging support. Sequences through all ACPx modes. Alternate ACP3, ACP2, ACP1, Galaxy, DCP.
1	< 4V	1	AUTOMODE enabled. Sequences through all ACPx modes. Alternate ACP3, ACP2, ACP1, DCP.

8.3.2 USB Power Management

The TUSB8044 can be configured for power switched applications using either per-port (Full power managed) or ganged power-enable controls and over-current status inputs. When battery charge is enabled, the TUSB8044 will always function in full power managed.

Power switch support is enabled by REG_5h (fullPwrMgmtz) and the per-port or ganged mode is configured by REG_5h(ganged).

The TUSB8044 supports both active high and active low power-enable controls. The PWRCTL[4:1] polarity is configured by REG_Ah(pwrctlPol).

8.3.3 I^2C Programming Support Using Internal Hid to I^2C Interface

The TUSB8044 I^2C programming mode is supported using class-specific requests through the HID interface. The HID's embedded port will be numbered 1 greater than the highest numbered exposed port. The internal HID to I^2C function of the TUSB8044 does not have an interrupt OUT endpoint. The TUSB8044 supports *GET REPORT (Input)* through the HID interrupt and control endpoints. The *GET REPORT (Feature)* and *SET REPORT (Output)* occurs through the control endpoint.

Table 3. HID Requests I^2C Programming Support

COMMAND	bmRequestType	bRequest	wValue	wIndex	wLength	DATA
Setup field Offset	Offset = 0	Offset = 1	Offset = 2	Offset = 4	Offset = 6	N/A
GET REPORT	A1H	01H	0100H – input 0300H - feature	0000H	Report Length	Report
SET REPORT	21H	09H	0200H – output	0000H	Report Length	Report

Other HID class specific requests are optional and not supported (SET IDLE, SET PROTOCOL, GET IDLE, GET PROTOCOL) . Also report IDs are not required since all requests are not interleaved.

8.3.3.1 SET REPORT (Output)

Report length includes overhead bytes (1 byte of opcode, 1 byte of device address and 2 bytes of data length) and must match the number of bytes sent in the data stage or the request will be stalled.

- 1-byte opcode
  - 0x01 read I2C
  - 0x02 write I2C with stop
  - 0x03 write I2C without stop (use to set sub-address prior to read)
- 1-byte I2C slave (7-bit) address
- 2-byte I2C transaction data length
- "length" bytes of Data for a write, but none for a read.

Set Report status stage reports only the status of the receipt and validity of the request, not the status of the I^2C transaction. As long as the fields construct a valid request, the status stage will be Acked by a null packet. Otherwise, it will be STALLed. For example, if the report_length is longer than the amount of data sent before the status stage or the wLength is greater than the number of bytes of data sent in the data stage, the status stage will be STALLed. If the number of bytes sent in the data stage is greater than wLength or report_length, the data stage will be STALLED.

Software shall ensure properly formatted commands and data responses. The sum of the start address and wLength shall be less than the total size of the address range of the target device in a properly formatted command. Hardware shall wrap any data addresses above FFFFh and shall discard any data transmitted greater than wLength and return STALL. A STALL will also be returned if opcode is 00h.

The I^2C master that performs the I^2C reads and writes initiated through USB HID interface supports clock stretching. It operates at 400 kHz by default, but can be configured for 100 kHz through eFuse or register.

If the TUSB8044 is suspended (L2) by the USB host, the USB HID interface must enter suspend, but the I^2C master shall remain active while attempting to complete an active I^2C write request. An active I^2C read request may be aborted if the TUSB8044 enters USB suspend state. Per the USB specification, the USB host should not suspend the HID interface while an I^2C read or write is still in progress. The USB HID interface shall refuse requests to enter USB 2.0 sleep mode (L1) while an I^2C read or write is in progress.

8.3.3.2 GET REPORT (Feature)

This HID Report will always return a 2-byte constant (0x82FF) which can be used to identify compatible HID devices even if the customer changes the VID/PID.

8.3.3.3 GET REPORT (Input)

A report length of one reports the status byte only. To receive a report with data, the report length must be the length of the data, plus one byte for status and two bytes for the length field.

- 1-byte Status
  - 0 Success
  - 1 Fail — timeout (35 ms)
  - 2 Fail — Address nak
  - 3 Fail — data nak
- 2-byte length
- "length" bytes of Data for a read, but not for a write or a feature report.

A Get Report (input) request is required for both read and write. The interrupt endpoint will NAK until the I^2C transaction is complete, so that it can report length, data for a read, and final status.

8.3.4 USB2.0 Billboard

Integrated in the TUSB8044 is a USB2.0 Billboard device which complies to the "*USB Device Class Definition for Billboard Devices Version 1.1*" specification. The billboard device is attached to the highest number downstream port of TUSB8044 USB2.0 hub. The purpose of the billboard is to communicate Alternate Mode status to the host system. The TUSB8044 supports only one Alternate Mode.

There are three pins, typically controlled by a USB Power Deliver (USB PD) controller, used to configure TUSB8044 Billboard functionality: BBEN, BBbmConfigured0, and BBbmConfigured1. The pins are only used when I2C mode is selected. If SMBus mode is selected, then TUSB8044 registers are used instead.

BBEN controls whether or not Billboard is presented to the Host system. When BBEN pin is high, the Billboard is presented to the Host system.

BBbmConfigured[1:0] pins map directly to the bmConfigured fields in the Billboard Capability Descriptor. These two pins must be set to reflect the Alternate Mode status before BBEN is asserted high. If Alternate Mode status changes after BBEN is high, BBEN must be transitioned low, BBbmConfigured[1:0] pins updated to reflect new status, and then BBEN asserted high. For cases in which USB PD controller only has one available GPIO to control TUSB8044 Billboard functionality, BBbmConfigured[1:0] pins should be tied to GND and BBEN pin must be asserted when an Alternate Mode failure occurs.

The TUSB8044 billboard capability descriptor fields can be changed using an external EEPROM. At power-up, the unique billboard fields from external EEPROM are loaded into TUSB8044 billboard. Fields controlled by EEPROM are described in Table 4. When an EEPROM is not used, the TUSB8044's default values as indicated in Table 4 is used.

Table 4. EEPROM Billboard Capability Descriptor Map

SIZE	I2C EEPROM ADDRESS	TUSB8044 DEFAULT WHEN EEPROM NOT USED	DESCRIPTION
2-bytes	0x28,0x27	0xFF01 (DisplayPort)	SVID.
2-bytes	0x2A,0x29	0x82EE	Billboard PID. Billboard and hub will share the same VID.
1-byte	0x2B	0x80	Billboard Configuration. When EEPROM used, this field must be set to 0x80.
1-byte	0x2C	0 = use default string in ROM	BBString1Len. # of Unicode characters (2 bytes each) in string 1. BBString1Len size + BBString2Len size must be <= 480 bytes, or < 480 if # characters in string 1 is odd, because string 2 must start on an address that is a multiple of 4 (bytes).
1-byte	0x2D	0 = use default string in ROM	BBString2Len. # of Unicode characters (2 bytes each) in string 2.
480 bytes	0x100	http://www.displayport.org	String 1. AdditionalInfoURL – required string descriptor providing a URL where the user can go to get more detailed information about the product and the various Alternate Modes it supports.
		"DisplayPort"	String 2. AlternateModeString – optional string to describe the alternate mode, which may include a URL. From Billboard spec, An example string is DisplayPort to VGA adapter. For further assistance, see http://help.vesa.org/dp-usb-type-c/.

8.3.5 One Time Programmable (OTP) Configuration

The TUSB8044 allows device configuration through one time programmable non-volatile memory (OTP). The programming of the OTP is supported using vendor-defined USB device requests. For details using the OTP features please contact your TI representative.

Table 5 provides a list features which may be configured using the OTP.

Table 5. OTP Configurable Features

CONFIGURATION REGISTER OFFSET	BIT FIELD	DESCRIPTION
REG_01h	[7:0]	Vendor ID LSB
REG_02h	[7:0]	Vendor ID MSB
REG_03h	[7:0]	Product ID LSB
REG_04h	[7:0]	Product ID MSB
REG_07h	[0]	Port removable configuration for downstream ports 1. OTP configuration is inverse of rmbl[3:0], i.e. 1 = not removable, 0 = removable.
REG_07h	[1]	Port removable configuration for downstream ports 2. OTP configuration is inverse of rmbl[3:0], i.e. 1 = not removable, 0 = removable.
REG_07h	[2]	Port removable configuration for downstream ports 3. OTP configuration is inverse of rmbl[3:0], i.e. 1 = not removable, 0 = removable.
REG_07h	[3]	Port removable configuration for downstream ports 4. OTP configuration is inverse of rmbl[3:0], i.e. 1 = not removable, 0 = removable.
REG_08h	[3:0]	Port used Configured register.
REG_0Ah	[3]	Enable Device Attach Detection..
REG_0Ah	[4]	High-current divider mode enable.
REG_0Bh	[0]	USB 2.0 port polarity configuration for downstream ports 1.
REG_0Bh	[1]	USB 2.0 port polarity configuration for downstream ports 2.
REG_0Bh	[2]	USB 2.0 port polarity configuration for downstream ports 3.
REG_0Bh	[3]	USB 2.0 port polarity configuration for downstream ports 4.
REG_25h	[4:0]	Device Configuration Register 3
REG_26h	[3:0]	USB2.0 Only Port Register
REG_F0h	[3:1]	USB power switch power-on delay.

8.3.6 Clock Generation

The TUSB8044 accepts a crystal input to drive an internal oscillator or an external clock source. If a clock is provided to XI instead of a crystal, XO is left open. Otherwise, if a crystal is used, the connection needs to follow the guidelines below. Since XI and XO are coupled to other leads and supplies on the PCB, it is important to keep them as short as possible and away from any switching leads. It is also recommended to minimize the capacitance between XI and XO. This can be accomplished by shielding C1 and C2 with the clean ground lines.

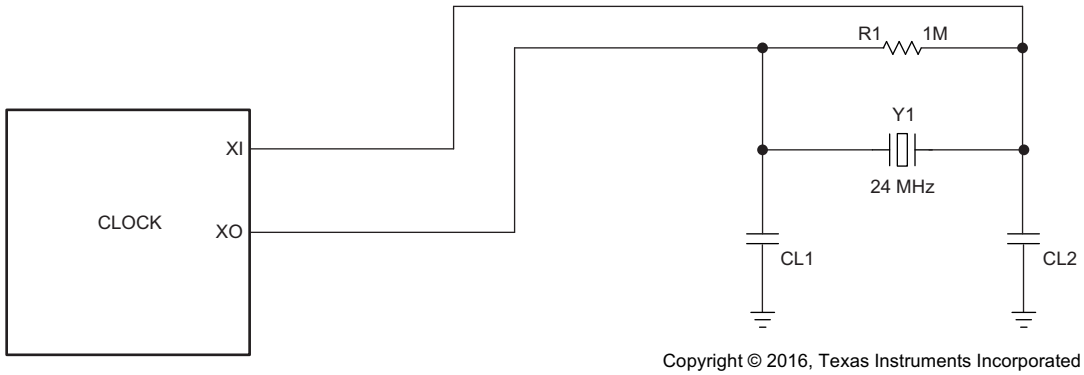


Figure 2. TUSB8044 Clock

8.3.7 Crystal Requirements

The crystal must be fundamental mode with load capacitance of 12 pF - 24 pF and frequency stability rating of ±100 PPM or better. To ensure proper startup oscillation condition, a maximum crystal equivalent series resistance (ESR) of 50 Ω is recommended. A parallel load capacitor should be used if a crystal source is used. The exact load capacitance value used depends on the crystal vendor. Refer to application note *Selection and Specification for Crystals for Texas Instruments USB2.0 devices* (SLLA122) for details on how to determine the load capacitance value.

8.3.8 Input Clock Requirements

When using an external clock source such as an oscillator, the reference clock should have a ±100 PPM or better frequency stability and have less than 50-ps absolute peak to peak jitter or less than 25-ps peak to peak jitter after applying the USB 3.1 jitter transfer function. XI should be tied to the 1.8-V clock source and XO should be left floating.

8.3.9 Power-Up and Reset

The TUSB8044 does not have specific power sequencing requirements with respect to the core power (VDD) or I/O and analog power (VDD33) as long as GRSTz is held in an asserted state while supplies ramp. The core power (VDD) or I/O power (VDD33) may be powered up for an indefinite period of time while the other is not powered up if all of these constraints are met:

- All maximum ratings and recommended operating conditions are observed.
- All warnings about exposure to maximum rated and recommended conditions are observed, particularly junction temperature. These apply to power transitions as well as normal operation.
- Bus contention while VDD33 is powered up must be limited to 100 hours over the projected life-time of the device.
- Bus contention while VDD33 is powered down may violate the absolute maximum ratings.

A supply bus is powered up when the voltage is within the recommended operating range. It is powered down when it is below that range, either stable or in transition.

A minimum reset duration of 3 ms is required. This is defined as the time when the power supplies are in the recommended operating range to the de-assertion of GRSTz. This can be generated using programmable-delay supervisory device or using an RC circuit. When a RC circuit is used, the external capacitor size chosen must be large enough to meet the 3ms minimum duration requirement. The R of the RC circuit is the internal R_{PU}.

8.4 Device Functional Modes

8.4.1 External Configuration Interface

The TUSB8044 supports a serial interface for configuration register access. The device may be configured by an attached I^2C EEPROM or accessed as a slave by an external SMBus master. The external interface is enabled when both the SCL/SMBCLK and SDA/SMBDAT pins are pulled up to 3.3 V at the de-assertion of reset. The mode, I^2C master or SMBus slave, is determined by the state of SMBUSz/SS_SUSPEND pin at reset. With the integrated USB HID to I^2C master, the I^2C interface can also be used to program an external EEPROM or perform updates of an external MCU's firmware.

8.4.2 I^2C EEPROM Operation

The TUSB8044 supports a single-master, fast mode (400KHz) connection to a dedicated I^2C EEPROM when the I^2C interface mode is enabled. In I^2C mode, the TUSB8044 reads the contents of the EEPROM at bus address 1010000b using 7-bit addressing starting at address 0. The TUSB8044 will read the entire EEPROM contents using a single burst read transaction. The burst read transaction will end when the address reaches 2DFh.

If the value of the EEPROM contents at address byte 00h equals 55h, the TUSB8044 loads the configuration registers according to the EEPROM map. If the first byte is not 55h, the TUSB8044 exits the I^2C mode and continues execution with the default values in the configuration registers. The hub will not connect on the upstream port until the configuration is completed.

NOTE

The bytes located above offset Ah are optional. The requirement for data in those addresses is dependent on the options configured in the Device Configuration, and Device Configuration 2 registers.

The minimum size I^2C EEPROM required is 8Kbit.

For details on I^2C operation refer to the UM10204 I^2C-bus Specification and User Manual.

8.4.3 Port Configuration

The TUSB8044 port configurations can be selected by registers or efuse. The Port Used Configuration register (USED[3:0]) define how many ports can possibly be reported by the hub. The device removable configuration register (RMBL[3:0]) define if the ports that are reported as used have permanently connected devices or not. The USB 2.0 Only Port register (USB2_ONLY[3:0]) define whether or a used port is reported as part of the USB 2.0 hub or both the USB2.0 and USB3.1 hubs. The USB2_ONLY field will enable the USB2.0 port even if the corresponding USED bit is low. The internal HID port will always be the second highest number USB2.0 port. The billboard port will always be the highest number USB2.0 port. The table below shows examples of the possible combinations.

Device Functional Modes (continued)

Table 6. TUSB8044 Downstream Port Configuration Examples

USED[3:0]	RMBL[3:0]	USB2_ONLY [3:0]	Reported Port Configuration	Physical to Logical Port mapping
1111	1111	0000	4 Port USB3.1 Hub 6 Port USB2.0 Hub Port 5 is permanently attached HID Port 6 is permanently attached Billboard	Physical1 => Logical Port1 for USB3.1 and USB2.0. Physical2 => Logical Port2 for USB3.1 and USB2.0. Physical3 => Logical Port3 for USB3.1 and USB2.0. Physical4 => Logical Port4 for USB3.1 and USB2.0. Physical5 => Logical Port5 for USB2.0. Physical6 => Logical Port6 for USB2.0.
1110	1111	0000	3 Port USB3.1 Hub 5 Port USB2.0 Hub Port 4 is permanently attached HID Port 5 is permanently attached Billboard.	Physical1 Not used. Physical2 => Logical Port1 for USB3.1 and USB2.0. Physical3 => Logical Port2 for USB3.1 and USB2.0. Physical4 => Logical Port3 for USB3.1 and USB2.0. Physical5 => Logical Port4 for USB 2.0. Physical6 => Logical Port5 for USB2.0.
1100	0111	0000	2 Port USB 3.1 Hub 4 Port USB2.0 hub with permanently attached device on Port 2 Port 3 is a permanently attached HID Port 4 is a permanently attached Billboard	Physical1 Not used. Physical2 Not used. Physical3 => Logical Port1 for USB3.1 and USB2.0. Physical4 => Logical Port2 for USB3.1 and USB2.0. Physical5 => Logical Port3 for USB2.0. Physical6 => Logical Port4 for USB2.0.
0011	1111	0010	1 Port USB 3.1 Hub 4 Port USB 2.0 Hub Port 3 is a permanently attached HID Port 4 is a permanently attached Billboard	Physical1 => Logical Port1 for USB3.1 and USB2.0. Physical2 => Logical Port2 for USB2.0. Physical3 Not Used. Physical4 Not used. Physical5 => Logical Port3 for USB2.0. Physical6 => Logical Port4 for USB2.0.
1000	1111	0010	1 Port USB 3.1 Hub 4 Port USB 2.0 Hub Port 3 is a permanently attached HID Port 4 is a permanently attached Billboard	Physical1 Not used. Physical2 => Logical Port2 for USB2.0. Physical3 Not used Physical4 => Logical Port1 for USB3.1 and USB2.0. Physical5 => Logical Port3 for USB2.0. Physical6 => Logical Port4 for USB2.0.
1111	1111	1110	1 Port USB 3.1 Hub 6 Port USB 2.0 Hub Port 5 is a permanently attached HID Port 6 is a permanently attached Billboard	Physical1 => Logical Port1 for USB3.1 and USB2.0. Physical2 => Logical Port2 for USB2.0. Physical3 => Logical Port3 for USB2.0. Physical4 => Logical Port4 for USB2.0. Physical5 => Logical Port5 for USB2.0. Physical6 => Logical Port6 for USB2.0.
1010	N/A	0x0x	Invalid combination when USB2_ONLY = 0000, 0001, 0100, or 0101. If invalid combination is used, then physical port 4 will not operate at USB3.1 Gen 1 speeds.	
1011	N/A	0x01	Invalid combination when USB2_ONLY = 0001 or 0101. If invalid combination is used, then physical port 4 will not operate at USB3.1 Gen 1 speeds.	
1110	N/A	010x	Invalid combination when USB2_ONLY = 0100 or 0101. If invalid combination is used, then physical port 4 will not operate at USB3.1 Gen 1 speeds.	

Device Functional Modes (continued)

Table 6. TUSB8044 Downstream Port Configuration Examples (continued)

USED[3:0]	RMBL[3:0]	USB2_ONLY [3:0]	Reported Port Configuration	Physical to Logical Port mapping
1111	N/A	0101	Invalid combination when USB2_ONLY = 0101. If invalid combination is used, then physical port 4 will not operate at USB3.1 Gen 1 speeds.	

8.4.4 SMBus Slave Operation

When the SMBus interface mode is enabled, the TUSB8044 supports read block and write block protocols as a slave-only SMBus device.

If the TUSB8044 is addressed by a host using an unsupported protocol it will not respond. The TUSB8044 waits indefinitely for configuration by the SMBus host and will not connect on the upstream port until the SMBus host indicates configuration is complete by clearing the CFG_ACTIVE bit.

Table 7. TUSB8044 SMBus 7-bit address Mapping

TUSB8044 7-bit Address	Register Range	Description
7'b1000100	00h thru FFh	Base 0 Registers
7'b1000101	100h thru 1FFh	Base 1 Registers for Billboard string 1 and 2
7'b1000110	200h thru 2DFh	Base 2 Registers for Billboard string 1 and 2

For details on SMBus requirements, refer to the System Management Bus Specification.

8.5 Register Maps

8.5.1 Configuration Registers

The internal configuration registers are accessed on byte boundaries. The configuration register values are loaded with defaults but can be over-written when the TUSB8044 is in I^2C or SMBus mode.

Table 8. TUSB8044 Register Map

BYTE ADDRESS	CONTENTS	EEPROM CONFIGURABLE
00h	ROM Signature Register	Yes
01h	Vendor ID LSB	Yes
02h	Vendor ID MSB	Yes
03h	Product ID LSB	Yes
04h	Product ID MSB	Yes
05h	Device Configuration Register	Yes
06h	Battery Charging Support Register	Yes
07h	Device Removable Configuration Register	Yes
08h	Port Used Configuration Register	Yes
09h	Reserved. Must default to 00h.	Yes
0Ah	Device Configuration Register 2	Yes
0Bh	USB 2.0 Port Polarity Control Register	Yes
0Ch-0Fh	Reserved	No
10h-1Fh	UUID Byte [15:0]	No
20h-21h	LangID Byte [1:0]	Yes
22h	Serial Number Length	Yes
23h	Manufacturer String Length	Yes
24h	Product String Length	Yes
25h	Device Configuration Register 3	Yes
26h	USB 2.0 Only Port Register	Yes
27h	Billboard SVID LSB	Yes
28h	Billboard SVID MSB	Yes
29h	Billboard PID LSB	Yes
2Ah	Billboard PID MSB	Yes
2Bh	Billboard Configuration	Yes
2Ch	Billboard String1Len	Yes
2Dh	Billboard String2Len	Yes
2Eh	Reserved	No
2Fh	Reserved	No
30h-4Fh	Serial Number String Byte [31:0]	Yes
50h-8Fh	Manufacturer String Byte [63:0]	Yes
90h-CFh	Product String Byte [63:0]	Yes
D0h-D4h	Reserved	Yes(1)
D5h-D7h	Reserved	No
D8h-DCh	Reserved	Yes(1)
DDh-EFh	Reserved	No
F0h	Additional Features Configuration Register	Yes
F1h-F7h	Reserved	No
F8h	SMBus Device Status and Command Register	No
F9h - FFh	Reserved	No
100h - 2DFh	USB Billboard Strings 1 and 2	Yes

8.5.2 ROM Signature Register

Figure 3. Register Offset 0h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 9. Bit Descriptions – ROM Signature Register

Bit	Field	Type	Description
7:0	romSignature	RW	ROM Signature Register. This register is used by the TUSB8044 in I^2C mode to validate the attached EEPROM has been programmed. The first byte of the EEPROM is compared to the mask 55h and if not a match, the TUSB8044 aborts the EEPROM load and executes with the register defaults.

8.5.3 Vendor ID LSB Register

Figure 4. Register Offset 1h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	1	0	1	0	0	0	1

Table 10. Bit Descriptions – Vendor ID LSB Register

Bit	Field	Type	Description
7:0	vendorIdLsb	RO/RW	Vendor ID LSB. Least significant byte of the unique vendor ID assigned by the USB-IF; the default value of this register is 51h representing the LSB of the TI Vendor ID 0451h. The value may be over-written to indicate a customer Vendor ID. Value used for this field will be the non-zero value written by EEPROM/SMBus to both PID and VID. If a zero value is written by EEPROM/SMbus to both PID and VID, then value used for this field will be the non-zero value from OTP. If a zero value is written by OTP, then value used for this field will be 51h.

8.5.4 Vendor ID MSB Register

Figure 5. Register Offset 2h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	1	0	0

Table 11. Bit Descriptions – Vendor ID MSB Register

Bit	Field	Type	Description
7:0	vendorIdMsb	RO/RW	Vendor ID MSB. Most significant byte of the unique vendor ID assigned by the USB-IF; the default value of this register is 04h representing the MSB of the TI Vendor ID 0451h. The value may be over-written to indicate a customer Vendor ID. Value used for this field will be the non-zero value written by EEPROM/SMBus to both PID and VID. If a zero value is written by EEPROM/SMbus to both PID and VID, then value used for this field will be the non-zero value from OTP. If a zero value is written by OTP, then value used for this field will be 04h.

8.5.5 Product ID LSB Register

Figure 6. Register Offset 3h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	1	0	0	0	0	0	0

Table 12. Bit Descriptions – Product ID LSB Register

Bit	Field	Type	Description
7:0	productIdLsb	RO/RW	Product ID LSB. Least significant byte of the product ID assigned by Texas Instruments and reported in the SuperSpeed Device descriptor. the default value of this register is 40h representing the LSB of the SuperSpeed product ID assigned by Texas Instruments The value reported in the USB 2.0 Device descriptor is the value of this register bit wise XORed with 00000010b. The value may be over-written to indicate a customer product ID. Value used for this field will be the non-zero value written by EEPROM/SMBus to both PID and VID. If a zero value is written by EEPROM/SMbus to both PID and VID, then value used for this field will be the non-zero value from OTP. If a zero value is written by OTP, then value used for this field will be 40h .

8.5.6 Product ID MSB Register

Figure 7. Register Offset 4h

Bit No.	7	6	5	4	3	2	1	0
Reset State	1	0	0	0	0	1	0	0

Table 13. Bit Descriptions – Product ID MSB Register

Bit	Field	Type	Description
7:0	productIdMsb	RO/RW	Product ID MSB. Most significant byte of the product ID assigned by Texas Instruments; the default value of this register is 84h representing the MSB of the product ID assigned by Texas Instruments. The value may be over-written to indicate a customer product ID. Value used for this field will be the non-zero value written by EEPROM/SMBus to both PID and VID. If a zero value is written by EEPROM/SMbus to both PID and VID, then value used for this field will be the non-zero value from OTP. If a zero value is written by OTP, then value used for this field will be 84h.

8.5.7 Device Configuration Register

Figure 8. Register Offset 5h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	1	0	0	0	0

Table 14. Bit Descriptions – Device Configuration Register

Bit	Field	Type	Description
7	customStrings	RW	Custom strings enable. This bit controls the ability to write to the Manufacturer String Length, Manufacturer String, Product String Length, Product String, and Language ID registers 0 = The Manufacturer String Length, Manufacturer String, Product String Length, Product String, and Language ID registers are read only 1 = The Manufacturer String Length, Manufacturer String, Product String Length, Product String, and Language ID registers may be loaded by EEPROM or written by SMBus The default value of this bit is 0.
6	customSernum	RW	Custom serial number enable. This bit controls the ability to write to the serial number registers. 0 = The Serial Number String Length and Serial Number String registers are read only 1 = Serial Number String Length and Serial Number String registers may be loaded by EEPROM or written by SMBus The default value of this bit is 0.
5	u1u2Disable	RW	U1 U2 Disable. This bit controls the U1/U2 support. 0 = U1/U2 support is enabled 1 = U1/U2 support is disabled, the TUSB8044 will not initiate or accept any U1 or U2 requests on any port, upstream or downstream, unless it receives or sends a Force_LinkPM_Accept LMP. After receiving or sending an FLPMA LMP, it will continue to enable U1 and U2 according to USB 3.1 protocol until it gets a power-on reset or is disconnected on its upstream port. When the TUSB8044 is in I^2C mode, the TUSB8044 loads this bit from the contents of the EEPROM. When the TUSB8044 is in SMBUS mode, the value may be over-written by an SMBus host.
4	RSVD	RO	Reserved. This bit is reserved and returns 1 when read.
3	ganged	RW	Ganged. 0 = When fullPwrMgmtz = 0, each port is individually power switched and enabled by the PWRCTL[4:1]/BATEN[4:1] pins 1 = When fullPwrMgmtz = 0, the power switch control for all ports is ganged and enabled by the PWRCTL[4:1]/BATEN1 pin When the TUSB8044 is in I^2C mode, the TUSB8044 loads this bit from the contents of the EEPROM. When the TUSB8044 is in SMBUS mode, the value may be over-written by an SMBus host.
2	fullPwrMgmtz	RW	Full Power Management. 0 = Port power switching status reporting is enabled 1 = Port power switching status reporting is disabled When the TUSB8044 is in I^2C mode, the TUSB8044 loads this bit from the contents of the EEPROM. When the TUSB8044 is in SMBUS mode, the value may be over-written by an SMBus host.
1	u1u2TimerOvr	RW	U1 U2 Timer Override. When this field is set, the TUSB8044 will override the downstream ports U1/U2 timeout values set by USB3.1 Host software. If software sets value in the range of 1h - FFh, the TUSB8044 will use the value of FFh. If software sets value to 0, then TUSB8044 will use value of 0.
0	RSVD	RO	Reserved. This field is reserved and returns 0 when read.

8.5.8 Battery Charging Support Register

Figure 9. Register Offset 6h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	X	X	X	X

Table 15. Bit Descriptions – Battery Charging Support Register

Bit	Field	Type	Description
7:4	RSVD	RO	Reserved. Read only, returns 0 when read.
3:0	batEn[3:0]	RW	Battery Charger Support. The bits in this field indicate whether the downstream port implements the charging port features. 0 = The port is not enabled for battery charging support features 1 = The port is enabled for battery charging support features Each bit corresponds directly to a downstream port, i.e. batEn0 corresponds to downstream port 1, and batEN1 corresponds to downstream port 2. The default value for these bits are loaded at the de-assertion of reset with the value of PWRCTL/BATEN[3:0]. When in I2C/SMBus mode the bits in this field may be over-written by EEPROM contents or by an SMBus host.

8.5.9 Device Removable Configuration Register

Figure 10. Register Offset 7h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	X	X	X	X

Table 16. Bit Descriptions – Device Removable Configuration Register

Bit	Field	Type	Description
7	customRmbl	RW	Custom Removable. This bit controls the ability to write to the port removable bits, port used bits, and USB2_ONLY bits. 0 = rmbl[3:0], used[3:0], and USB2_ONLY[3:0] are read only and the values are loaded from the OTP ROM 1 = rmbl[3:0], used[3:0], and USB2_ONLY[3:0] are read/write and can be loaded by EEPROM or written by SMBus This bit may be written simultaneously with rmbl[3:0].
6:4	RSVD	RO	Reserved. Read only, returns 0 when read.
3:0	rmbl[3:0]	RO/RW	Removable. The bits in this field indicate whether a device attached to downstream ports 4 through 1 are removable or permanently attached. 0 = The device attached to the port is not removable 1 = The device attached to the port is removable Each bit corresponds directly to a downstream port n + 1, i.e. rmbl0 corresponds to downstream port 1, rmbl1 corresponds to downstream port 2, etc. This field is read only unless the customRmbl bit is set to 1. Otherwise the value of this filed reflects the inverted values of the OTP ROM non_rmb[3:0] field.

8.5.10 Port Used Configuration Register

Figure 11. Register Offset 8h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	1	1	1	1

Table 17. Bit Descriptions – Port Used Configuration Register

Bit	Field	Type	Description
7:4	RSVD	RO	Reserved. Read only.
3:0	used[3:0]	RO/RW	Used. The bits in this field indicate whether a port is enabled. 0 = The port is not used or disabled 1 = The port is used or enabled Each bit corresponds directly to a downstream port, i.e. used0 corresponds to downstream port 1, used1 corresponds to downstream port 2, etc. All combinations are supported with the exception of both ports 1 and 3 marked as disabled. This field is read only unless the customRmbl bit is set to 1. When the corresponding USB2_ONLY bit is set, the USB2 port will be used and enabled regardless of the bit programmed into this field.

8.5.11 Device Configuration Register 2

Figure 12. Register Offset Ah

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	X	1	0	0	0	0

Table 18. Bit Descriptions – Device Configuration Register 2

Bit	Field	Type	Description
7	Reserved	RO	Reserved. Read-only, returns 0 when read.
6	customBCfeatures	RW	Custom Battery Charging Feature Enable. This bit controls the ability to write to the battery charging feature configuration controls. 0 = The HiCurAcpModeEn is read only and the values are loaded from the OTP ROM. 1 = The HiCurAcpModeEn bit is read/write and can be loaded by EEPROM or written by SMBus. This bit may be written simultaneously with HiCurAcpModeEn.
5	pwrctlPol	RW	Power enable polarity. This bit is loaded at the de-assertion of reset with the value of the PWRCTL_POL pin. 0 = PWRCTL polarity is active low 1 = PWRCTL polarity is active high When the TUSB8044 is in I^2C mode, the TUSB8044 loads this bit from the contents of the EEPROM. When the TUSB8044 is in SMBUS mode, the value may be over-written by an SMBus host.
4	HiCurAcpModeEn	RO/RW	High-current ACP mode enable. This bit enables the high-current tablet charging mode when the automatic battery charging mode is enabled for downstream ports. 0 = High current divider mode disabled . High current is ACP2 (default) 1 = High current divider mode enabled. High current mode is ACP3 This bit is read only unless the customBCfeatures bit is set to 1. If customBCfeatures is 0, the value of this bit reflects the value of the OTP ROM HiCurAcpModeEn bit.
3:2	Reserved	RW	Reserved
1	autoModeEnz	RW	Automatic Mode Enable. The automatic mode only applies to downstream ports with battery charging enabled when the upstream port is not connected. Under these conditions: 0 = Automatic mode battery charging features are enabled. 1 = Automatic mode is disabled; only Battery Charging DCP and CDP mode is supported. NOTE: When the upstream port is connected, Battery Charging CDP mode will be supported on all ports that are enabled for battery charging support regardless of the value of this bit.
0	RSVD	RO	Reserved. Read only, returns 0 when read.

8.5.12 USB 2.0 Port Polarity Control Register

Figure 13. Register Offset Bh

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 19. Bit Descriptions – USB 2.0 Port Polarity Control Register

Bit	Field	Type	Description
7	customPolarity	RW	Custom USB 2.0 Polarity. This bit controls the ability to write the p[4:0]_usb2pol bits. 0 = The p[4:0]_usb2pol bits are read only and the values are loaded from the OTP ROM. 1 = The p[4:0]_usb2pol bits are read/write and can be loaded by EEPROM or written by SMBus. This bit may be written simultaneously with the p[4:0]_usb2pol bits
6:5	RSVD	RO	Reserved. Read only, returns 0 when read.
4	p4_usb2pol	RO/RW	Downstream Port 4 DM/DP Polarity. This controls the polarity of the port. 0 = USB 2.0 port polarity is as documented by the pin out 1 = USB 2.0 port polarity is swapped from that documented in the pin out, i.e. DM becomes DP, and DP becomes DM. This bit is read only unless the customPolarity bit is set to 1. If customPolarity is 0 the value of this bit reflects the value of the OTP ROM p4_usb2pol bit.
3	p3_usb2pol	RO/RW	Downstream Port 3 DM/DP Polarity. This controls the polarity of the port. 0 = USB 2.0 port polarity is as documented by the pin out 1 = USB 2.0 port polarity is swapped from that documented in the pin out, i.e. DM becomes DP, and DP becomes DM. This bit is read only unless the customPolarity bit is set to 1. If customPolarity is 0 the value of this bit reflects the value of the OTP ROM p3_usb2pol bit.
2	p2_usb2pol	RO/RW	Downstream Port 2 DM/DP Polarity. This controls the polarity of the port. 0 = USB 2.0 port polarity is as documented by the pin out 1 = USB 2.0 port polarity is swapped from that documented in the pin out, i.e. DM becomes DP, and DP becomes DM. This bit is read only unless the customPolarity bit is set to 1. If customPolarity is 0 the value of this bit reflects the value of the OTP ROM p2_usb2pol bit.
1	p1_usb2pol	RORW	Downstream Port 1 DM/DP Polarity. This controls the polarity of the port. 0 = USB 2.0 port polarity is as documented by the pin out 1 = USB 2.0 port polarity is swapped from that documented in the pin out, i.e. DM becomes DP, and DP becomes DM. This bit is read only unless the customPolarity bit is set to 1. If customPolarity is 0 the value of this bit reflects the value of the OTP ROM p1_usb2pol bit.
0	p0_usb2pol	RO/RW	Upstream Port DM/DP Polarity. This controls the polarity of the port. 0 = USB 2.0 port polarity is as documented by the pin out 1 = USB 2.0 port polarity is swapped from that documented in the pin out, i.e. DM becomes DP, and DP becomes DM. This bit is read only unless the customPolarity bit is set to 1. If customPolarity is 0 the value of this bit reflects the value of the OTP ROM p0_usb2pol bit.

8.5.13 UUID Registers

Figure 14. Register Offset 10h-1Fh

Bit No.	7	6	5	4	3	2	1	0
Reset State	X	X	X	X	X	X	X	X

Table 20. Bit Descriptions – UUID Byte N Register

Bit	Field	Type	Description
7:0	uuidByte[n]	RO	UUID byte N. The UUID returned in the Container ID descriptor. The value of this register is provided by the device and is meets the UUID requirements of Internet Engineering Task Force (IETF) RFC 4122 A UUID URN Namespace.

8.5.14 Language ID LSB Register

Figure 15. Register Offset 20h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	1	0	0	1

Table 21. Bit Descriptions – Language ID LSB Register

Bit	Field	Type	Description
7:0	langIdLsb	RO/RW	Language ID least significant byte. This register contains the value returned in the LSB of the LANGID code in string index 0. The TUSB8044 only supports one language ID. The default value of this register is 09h representing the LSB of the LangID 0409h indicating English United States. When customStrings is 1, this field may be over-written by the contents of an attached EEPROM or by an SMBus host.

8.5.15 Language ID MSB Register

Figure 16. Register Offset 21h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 22. Bit Descriptions – Language ID MSB Register

Bit	Field	Type	Description
7:0	langIdMsb	RO/RW	Language ID most significant byte. This register contains the value returned in the MSB of the LANGID code in string index 0. The TUSB8044 only supports one language ID. The default value of this register is 04h representing the MSB of the LangID 0409h indicating English United States. When customStrings is 1, this field may be over-written by the contents of an attached EEPROM or by an SMBus host.

8.5.16 Serial Number String Length Register

Figure 17. Register Offset 22h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	1	1	0	0	0

Table 23. Bit Descriptions – Serial Number String Length Register

Bit	Field	Type	Description
7:6	RSVD	RO	Reserved. Read only, returns 0 when read.
5:0	serNumStringLen	RO/RW	Serial number string length. The string length in bytes for the serial number string. The default value is 18h indicating that a 24 byte serial number string is supported. The maximum string length is 32 bytes. When customSernum is 1, this field may be over-written by the contents of an attached EEPROM or by an SMBus host. When the field is non-zero, a serial number string of serNumbStringLen bytes is returned at string index 1 from the data contained in the Serial Number String registers.

8.5.17 Manufacturer String Length Register

Figure 18. Register Offset 23h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 24. Bit Descriptions – Manufacturer String Length Register

Bit	Field	Type	Description
7	RSVD	RO	Reserved. Read only, returns 0 when read.
6:0	mfgStringLen	RO/RW	Manufacturer string length. The string length in bytes for the manufacturer string. The default value is 0, indicating that a manufacturer string is not provided. The maximum string length is 64 bytes. When customStrings is 1, this field may be over-written by the contents of an attached EEPROM or by an SMBus host. When the field is non-zero, a manufacturer string of mfgStringLen bytes is returned at string index 3 from the data contained in the Manufacturer String registers.

8.5.18 Product String Length Register

Figure 19. Register Offset 24h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 25. Bit Descriptions – Product String Length Register

Bit	Field	Type	Description
7	RSVD	RO	Reserved. Read only, returns 0 when read.
6:0	prodStringLen	RO/RW	Product string length. The string length in bytes for the product string. The default value is 0, indicating that a product string is not provided. The maximum string length is 64 bytes. When customStrings is 1, this field may be over-written by the contents of an attached EEPROM or by an SMBus host. When the field is non-zero, a product string of prodStringLen bytes is returned at string index 3 from the data contained in the Product String registers.

8.5.19 Device Configuration Register 3

Figure 20. Register Offset 25h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 26. Bit Descriptions – Device Configuration Register 3

Bit	Field	Type	Description
7:5	RSVD	RO	Reserved. Read only, returns 0 when read.
4	USB2.0_only	RW	USB 2.0 hub reports as 2.0 only. This bit disables the USB 2.0 hub from reporting 5Gbps support in the wSpeedsSupported field of the USB SS BOS SS device capability descriptor. This bit will also disable the USB3.0 hub. This bit is read/write but the read value returned is the Boolean OR of this bit and the corresponding eFuse bit. If either bit is set, this feature is enabled.
3	Reserved	RO	Switch to reserved
2	I2C_100k	R/W	I2C 100kHz. This bit controls the clock rate of the I2C master for both USB to I2C requests . The EEPROM reads will occur at 400K unless eFuse is used to set the rate to 100k. This bit is read/write but the read value returned is the Boolean OR of this bit and the corresponding eFuse bit. If either bit is set, this feature is enabled.
1	Galaxy_Enz	R/W	Disable Galaxy compatible modes. When this field is high, Galaxy charging compatible mode will not be included in AUTOMODE charger sequence. This bit is read/write but the read value returned is the Boolean OR of this bit and the corresponding eFuse bit. If either bit is set, this feature is disabled.
0	FullAutoEn	R/W	Enable all divider battery charging modes. When automode is enabled and this bit is set, any DS port enabled for battery charging will attempt all divider battery charging modes before DCP, starting with the highest current option. The bit is writable, but the value read back is the Boolean OR of this bit and the corresponding eFuse control. If either bit is set, eFuse or this register, this feature is enabled.

8.5.20 USB 2.0 Only Port Register

Figure 21. Register Offset 26h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 27. Bit Descriptions – USB 2.0 Only Port Register

Bit	Field	Type	Description
7:4	RSVD	RO	Reserved. Read only, returns 0 when read.
3:0	USB2_ONLY[3:0]	RO/RW	USB 2.0 Only Ports. The bits in this field primarily indicate whether a port is enabled only for USB 2.0 operation. This field is read-only unless customRmbl bit is set. Also, these bits will override the corresponding USED bit. A value of 0 indicates the hub port is enabled for both USB 3.1 and USB 2.0. A value of 1 indicates the hub port is enabled only for USB 2.0 operation.

8.5.21 Billboard SVID LSB

Figure 22. Register Offset 27h (Billboard SVID LSB)

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	1

Table 28. Bit Descriptions – Billboard SVID LSB

Bit	Field	Type	Description
7:0	SVID_LSB	RW	SVID. This field is the LSB of the 16-bit SVID. This field defaults to 0x01 but can be changed using an external I^2C EEPROM or SMBus.

8.5.22 Billboard SVID MSB

Figure 23. Register Offset 28h (Billboard SVID MSB)

Bit No.	7	6	5	4	3	2	1	0
Reset State	1	1	1	1	1	1	1	1

Table 29. Bit Descriptions – Billboard SVID MSB

Bit	Field	Type	Description
7:0	SVID_MSB	RW	SVID. This field is the MSB of the 16-bit SVID. This field defaults to 0xFF but can be changed using an external I^2C EEPROM or SMBus.

8.5.23 Billboard PID LSB

Figure 24. Register Offset 29h (Billboard PID LSB)

Bit No.	7	6	5	4	3	2	1	0
Reset State	1	1	1	0	1	1	1	0

Table 30. Bit Descriptions – Billboard PID LSB

Bit	Field	Type	Description
7:0	BBPID_LSB	RW	Billboard PID LSB. This field represents the LSB of the 16-bit PID. This field defaults to 0xEE but can be changed using an external I^2C EEPROM or SMBus

8.5.24 Billboard PID MSB

Figure 25. Register Offset 2Ah (Billboard PID MSB)

Bit No.	7	6	5	4	3	2	1	0
Reset State	1	0	0	0	0	0	1	0

Table 31. Bit Descriptions – Billboard PID MSB

Bit	Field	Type	Description
7:0	BBPID_LSB	RW	Billboard PID MSB. This field represents the MSB of the 16-bit PID. This field defaults to 0x82 but can be changed using an external I^2C EEPROM or SMBus.

8.5.25 Billboard Configuration

Figure 26. Register Offset 2Bh (Billboard Configuration)

Bit No.	7	6	5	4	3	2	1	0
Reset State	1	0	0	0	X	X	0	0

Table 32. Bit Descriptions – Billboard Configuration.

Bit	Field	Type	Description
7:4	VCONN_PWR	RW	VCONN power. This field is used when SMBus mode is selected. When I2C mode is selected, this field is read-only and will always return 1000b. The TUSB8044 will use value programmed into this register to update the VCONN Power field in the Billboard Capability Descriptor. 0000b: 1 Watt 0001b: 1.5 Watts 0010b: 2 Watts 0011b: 3 Watts 0100b: 4 Watts 0101b: 5 Watts 0110b: 6 Watts 0111b: Reserved. 1XXXb: The adapter does NOT require any Vconn power.
3:2	bbConfigured[1:0]	RW	bmConfigured[1:0]. This field is used when SMBus mode is selected. Controls the bmConfigured[1:0] fields in the Billboard Capability Descriptor. When I2C mode is selected, then bmConfigured[1:0] fields are read-only and values are determined by BBbmConfigured[1:0] pins. 00b: Unspecified Error 01b: Alternate Mode Configuration Not attempted. 10b: Alternate Mode configured attempted but unsuccessful. 11b: Alternate Mode configured successfully.
1	bAdditionalFailureInfo	RW	bAdditionalFailureInfo. This field is used when SMBus mode is selected. This field is ignored if VCONN_PWR[3] is set. The value programmed into this field will be presented in the bAdditionalFailureInfo field in the Billboard Capability Descriptor. When in I2C mode, this field is read-only and defaults to 0.
0	BillboardEN	RW	Billboard Enable. This field is used when SMBus mode is selected. When I2C mode is selected, this field is read-only and Billboard connected state is determined by BBEN pin. 0b: Billboard not connected. 1b: Billboard connected.

8.5.26 Billboard String1 Length

Figure 27. Register Offset 2Ch (Billboard String1 Length)

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	1	0	1	1	0	0

Table 33. Bit Descriptions – Billboard String1 Length.

Bit	Field	Type	Description
7:0	BBString1Len	RW	Billboard String1Len. This field indicates the length in number of UNICODE characters of the Billboard string1. This is not the length of the string descriptor. BBString1Len size + BBString2Len size must be <= 480 bytes, or < 480 if # characters in string 1 is odd, because string 2 must start on an address that is a multiple of 4 (bytes). The bLength field of the Additional Info URL string descriptor is 2 + (2 * BBString1Len). This field defaults to 0x2C but can be changed using an external I^2C EEPROM or SMBus.

8.5.27 Billboard String2 Length

Figure 28. Register Offset 2Dh (Billboard String2 Length)

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	1	0	1	1	0	0

Table 34. Bit Descriptions – Billboard String2 Length.

Bit	Field	Type	Description
7:0	BBString2Len	RW	Billboard String2Len. This field indicates the length in number of UNICODE characters of the Billboard string2. This is not the length of the string descriptor. The bLength field of the Alternate Mode string descriptor is 2 + (2 * BBString2Len). This field defaults to 0x2D but can be changed using an external I^2C EEPROM or SMBus.

8.5.28 Serial Number String Registers

Figure 29. Register Offset 30h-4Fh

Bit No.	7	6	5	4	3	2	1	0
Reset State	X	X	x	x	x	x	x	x

Table 35. Bit Descriptions – Serial Number Registers

Bit	Field	Type	Description
7:0	serialNumber[n]	RO/RW	Serial Number byte N. The serial number returned in the Serial Number string descriptor at string index 1. The default value of these registers is assigned by TI. When customSernum is 1, these registers may be over-written by EEPROM contents or by an SMBus host.

8.5.29 Manufacturer String Registers

Figure 30. Register Offset 50h-8Fh

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 36. Bit Descriptions – Manufacturer String Registers

Bit	Field	Type	Description
7:0	mfgStringByte[n]	RW	Manufacturer string byte N. These registers provide the string values returned for string index 3 when mfgStringLen is greater than 0. The number of bytes returned in the string is equal to mfgStringLen. The programmed data should be in UNICODE UTF-16LE encodings as defined by The Unicode Standard, Worldwide Character Encoding, Version 5.0.

8.5.30 Product String Registers

Figure 31. Register Offset 90h-CFh

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 37. Bit Descriptions – Product String Byte N Register

Bit	Field	Type	Description
7:0	prodStringByte[n]	RO/RW	Product string byte N. These registers provide the string values returned for string index 2 when prodStringLen is greater than 0. The number of bytes returned in the string is equal to prodStringLen. The programmed data should be in UNICODE UTF-16LE encodings as defined by The Unicode Standard, Worldwide Character Encoding, Version 5.0.

8.5.31 Additional Feature Configuration Register

Figure 32. Register Offset F0h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 38. Bit Descriptions – Additional Feature Configuration Register

Bit	Field	Type	Description
7:5	Reserved	RW	Reserved. This field defaults to 3'b000 and must not be changed.
4	stsOutputEn	RW	Status output enable. This field when set enables of the Status output signals, HS_UP, HS_SUSPEND, SS_UP, SS_SUSPEND. 0 = STS outputs are disabled. 1 = STS outputs are enabled. This bit may be loaded by EEPROM or over-written by a SMBUS host.
3:1	pwronTime	RW	Power On Delay Time. When the efuse_pwronTime field is all 0s, this field sets the delay time from the removal disable of PWRCTL to the enable of PWRCTL when transitioning battery charging modes. For example, when disabling the power on a transition from ACP to DCP Mode. The nominal timing is defined as follows: TPWRON_EN = (pwronTime x 1) x 200 ms (1) This field may be over-written by EEPROM contents or by an SMBus host.
0	usb3spreadDis	RW	USB3 Spread Spectrum Disable. This bit allows firmware to disable the spread spectrum function of the USB3 phy PLL. 0 = Spread spectrum function is enabled 1= Spread spectrum function is disabled This bit may be loaded by EEPROM or over-written by a SMBUS host.

8.5.32 SMBus Device Status and Command Register

Figure 33. Register Offset F8h

Bit No.	7	6	5	4	3	2	1	0
Reset State	0	0	0	0	0	0	0	0

Table 39. Bit Descriptions – SMBus Device Status and Command Register

Bit	Field	Type	Description
7:2	RSVD	RO	Reserved. Read only, returns 0 when read.
1	smbusRst	RSU	SMBus interface reset. This bit loads the registers back to their GRSTz values. Note, that since this bit can only be set when in SMBus mode the cfgActive bit is also reset to 1. When software sets this bit it must reconfigure the registers as necessary. This bit is set by writing a 1 and is cleared by hardware on completion of the reset. A write of 0 has no effect.
0	cfgActive	RCU	Configuration active. This bit indicates that configuration of the TUSB8044 is currently active. The bit is set by hardware when the device enters the I2C or SMBus mode. The TUSB8044 shall not connect on the upstream port while this bit is 1. When in I2C mode, the bit is cleared by hardware when the TUSB8044 exits the I2C mode. When in the SMBus mode, this bit must be cleared by the SMBus host in order to exit the configuration mode and allow the upstream port to connect. The bit is cleared by a writing 1. A write of 0 has no effect.

8.5.33 Billboard String1_2

Figure 34. Register Offset 100h - 2DFh (Billboard String1_2)

Bit No.	7	6	5	4	3	2	1	0
Reset State	X	X	X	X	X	X	X	X

Table 40. Bit Descriptions – Billboard String1_2

Bit	Field	Type	Description
7:0	BBString12	W	Billboard String1 and String2. This field can only be written to and can not be read from. String 1 defaults http://www.displayport.org String 2 defaults to "DisplayPort" The default can be changed using an external I^2C EEPROM or SMBus.

9 Applications and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The TUSB8044 is a four-port USB 3.1 Gen1 compliant hub. It provides simultaneous SuperSpeed USB and high-speed/full-speed connections on the upstream port and provides SuperSpeed USB, high-speed, full-speed, or low speed connections on the downstream port. The TUSB8044 can be used in any application that needs additional USB compliant ports. For example, a specific notebook may only have two downstream USB ports. By using the TUSB8044, the notebook can increase the downstream port count to five.

9.2 Typical Application

9.2.1 Discrete USB Hub Product

A common application for the TUSB8044 is as a self powered standalone USB Type-C docking product. The product is powered by an external 5V DC Power adapter. In this application, using a USB Type-C captive cable the TUSB8044 upstream port is plugged into a USB Host controller. The downstream ports of the TUSB8044 are exposed to users for connecting USB hard drives, cameras, flash drives, and so forth. There is also a DisplayPort receptacle for connected an external DisplayPort monitor.

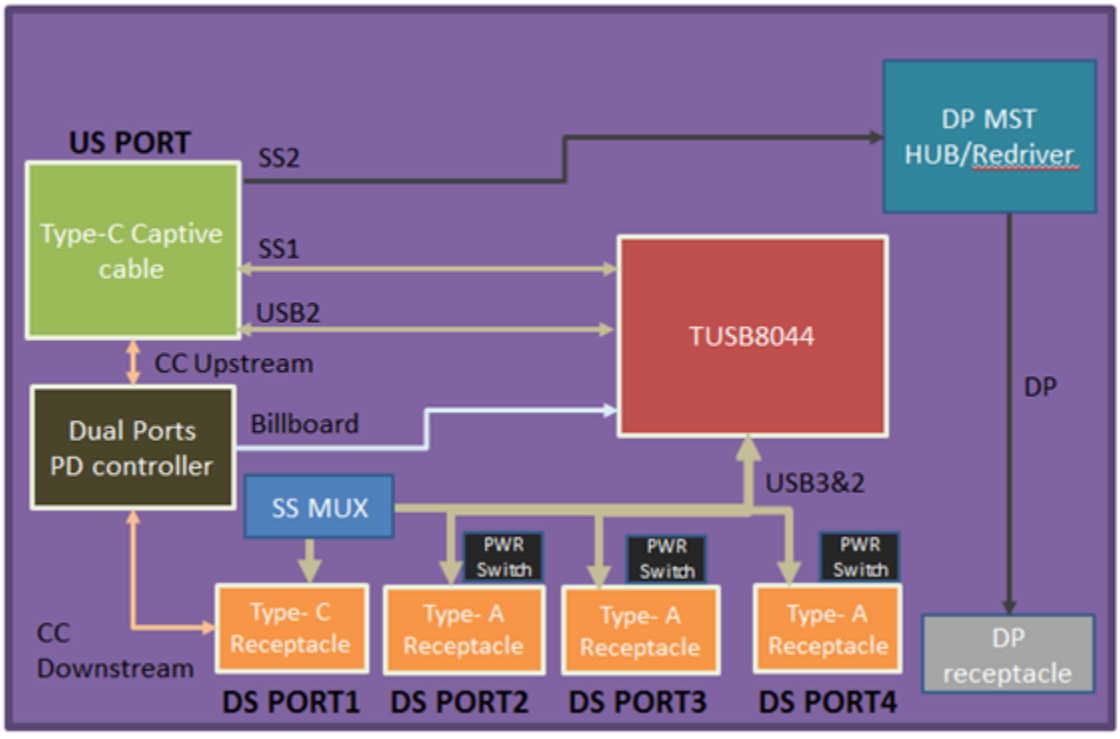


Figure 35. Discrete USB Hub Product

Typical Application (continued)

9.2.1.1 Design Requirements

Table 41. Design Parameters

DESIGN PARAMETER	EXAMPLE VALUE
VDD Supply	1.1 V
VDD33 Supply	3.3 V
Upstream Port USB Support (SS, HS, FS)	SS, HS, FS
Downstream Port 1 USB Support (SS, HS, FS, LS)	SS, HS, FS, LS
Downstream Port 2 USB Support (SS, HS, FS, LS)	SS, HS, FS, LS
Downstream Port 3 USB Support (SS, HS, FS, LS)	SS, HS, FS, LS
Downstream Port 4 USB Support (SS, HS, FS, LS)	SS, HS, FS, LS
Number of Removable external exposed Downstream Ports	4
Number of Non-Removable external exposed Downstream Ports	0
Full Power Management of Downstream Ports	Yes. (FULLPWRMGMTZ = 0)
Individual Control of Downstream Port Power Switch	Yes. (GANGED = 0)
Power Switch Enable Polarity	Active High. (PWRCTL_POL = 1)
Battery Charge Support for Downstream Port 1	Yes
Battery Charge Support for Downstream Port 2	Yes
Battery Charge Support for Downstream Port 3	Yes
Battery Charge Support for Downstream Port 4	Yes
I2C EEPROM Support	Yes
24MHz Clock Source	Crystal

9.2.1.2 Detailed Design Procedure

9.2.1.2.1 Upstream Port Implementation

The upstream of the TUSB8044 is connected to a USB Type-C captive cable. The system VBUS signal from the USB3 Type C plug is fed through a voltage divider. The purpose of the voltage divider is to make sure the system VBUS level meets TUSB8044 USB_VBUS input requirements. The voltage divider in this particular implementation will support up to 11.4V VBUS. If VBUS needs to be greater, then PD controller will need to directly control TUSB8044 USB_VBUS input. The USB-C plug has two pairs of USB3.1 differential pairs (RX1/TX1 and RX2/TX2). In this particular example, one pair of super speed signals (RX2 and TX2) from Type-C plug is connected to the DP Hub/Retimer/Redriver. The other pair of super speed signals (RX1 and TX2) is routed to the TUSB8044. The CC1 and VCONN signals from the Type-C plug is connected to the USB PD controller.

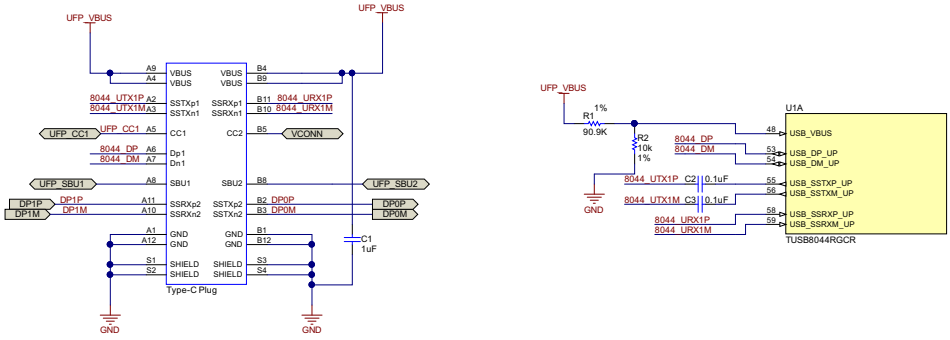


Figure 36. Upstream Port Implementation

9.2.1.2.2 Downstream Port 1 Implementation

The downstream port 1 of the TUSB8044 is connected to a USB Type-C receptacle. With BATEN1 pin pulled up, Battery Charge support is enabled for Port 1. If Battery Charge support is not needed, then pull-up resistor on BATEN1 should be uninstalled. A 1:2 MUX passive MUX is used to route the hub downstream port's super speed signals to the appropriate location on the USB Type-C receptacle. The MUX orientation is controlled by the PD controller through the SEL signal. A example 1:2 passive MUX that could be used is the Texas Instrument's HD3SS3212.

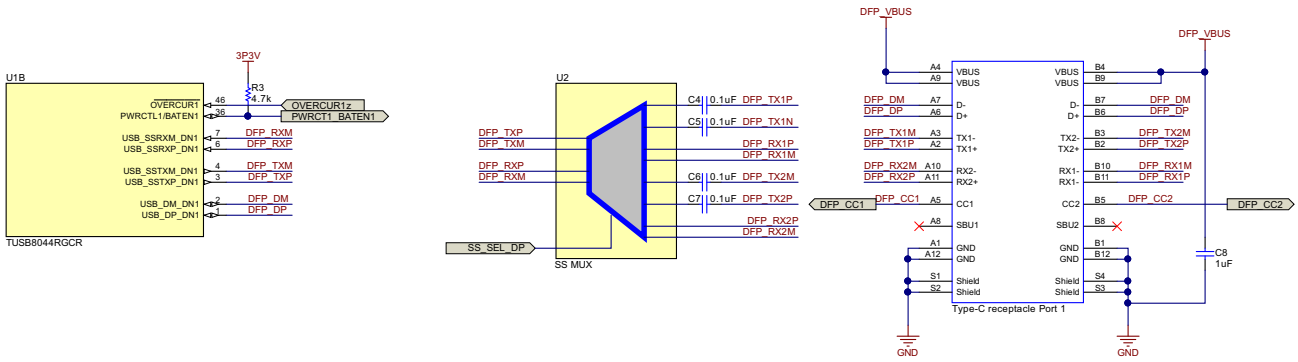


Figure 37. Downstream Port 1 Implementation

9.2.1.2.3 Downstream Port 2 Implementation

The downstream port 2 of the TUSB8044 is connected to a USB3 Type A connector. With BATEN2 pin pulled up, Battery Charge support is enabled for Port 2. If Battery Charge support is not needed, then pull-up resistor on BATEN2 should be uninstalled. For ferrite bead used on the VBUS connection, a lower resistance is recommended due to noticeable IR drop during high current charging modes. The isolation between the Type-A connectors shield ground and signal ground pins is not required. Some applications may have better ESD/EMI performance when the grounds are shorted together.

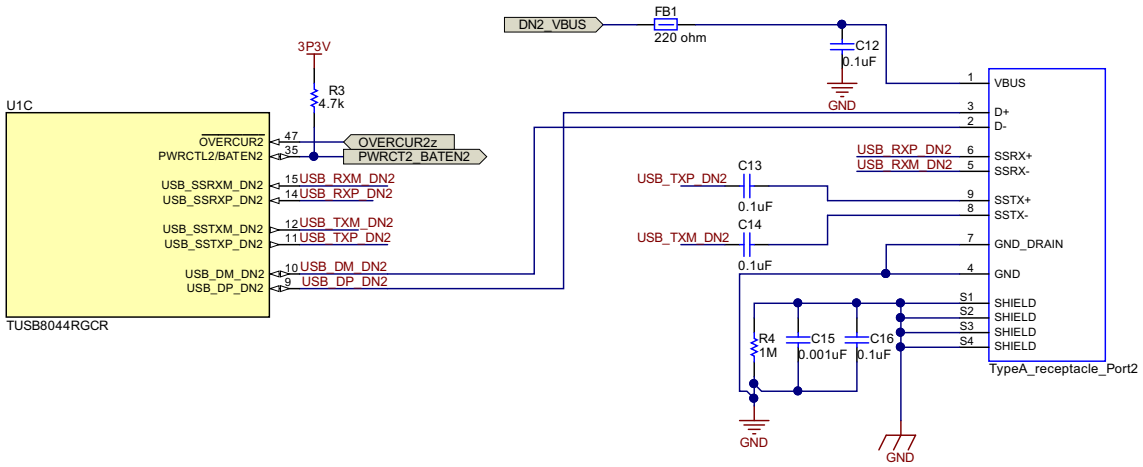


Figure 38. Downstream Port 2 Implementation

9.2.1.2.4 Downstream Port 3 Implementation

The downstream port3 of the TUSB8044 is connected to a USB3 Type A connector. With BATEN3 pin pulled up, Battery Charge support is enabled for Port 3. If Battery Charge support is not needed, then pull-up resistor on BATEN3 should be uninstalled. For ferrite bead used on the VBUS connection, a lower resistance is recommended due to noticeable IR drop during high current charging modes. The isolation between the Type-A connectors shield ground and signal ground pins is not required. Some applications may have better ESD/EMI performance when the grounds are shorted together.

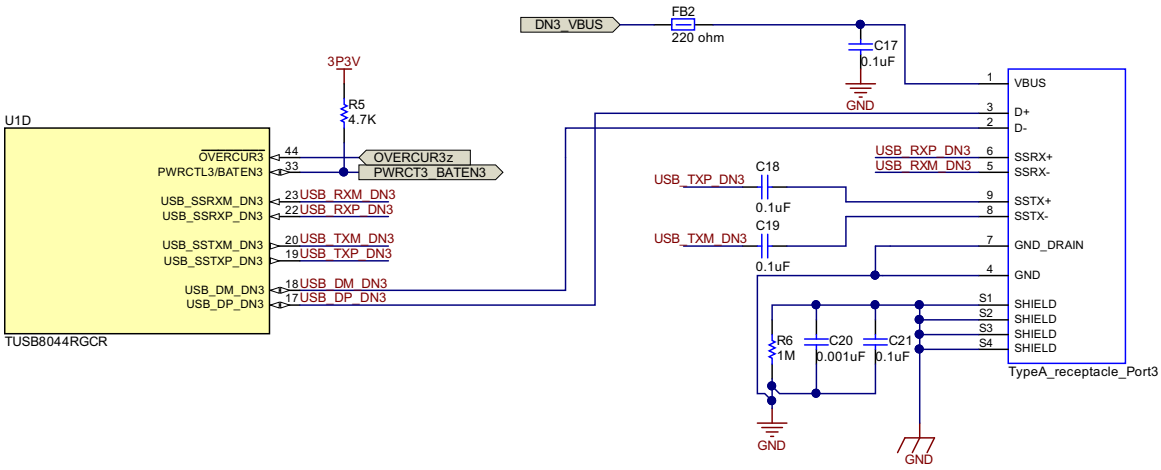


Figure 39. Downstream Port 3 Implementation

9.2.1.2.5 Downstream Port 4 Implementation

The downstream port 4 of the TUSB8044 is connected to a USB3 Type A connector. With BATEN4 pin pulled up, Battery Charge support is enabled for Port 4. If Battery Charge support is not needed, then pull-up resistor on BATEN4 should be uninstalled. For ferrite bead used on the VBUS connection, a lower resistance is recommended due to noticeable IR drop during high current charging modes. The isolation between the Type-A connectors shield ground and signal ground pins is not required. Some applications may have better ESD/EMI performance when the grounds are shorted together.

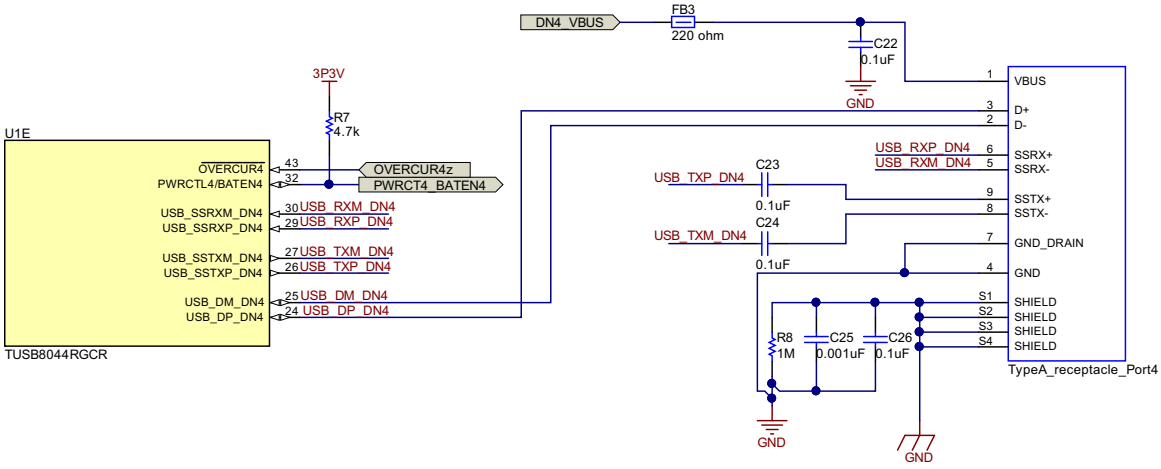


Figure 40. Downstream Port 4 Implementation

9.2.1.2.6 VBUS Power Switch Implementation

This particular example uses the Texas Instruments TPS2561 Dual Channel Precision Adjustable Current-Limited power switch. For details on this power switch or other power switches available from Texas Instruments, refer to the Texas Instruments website.

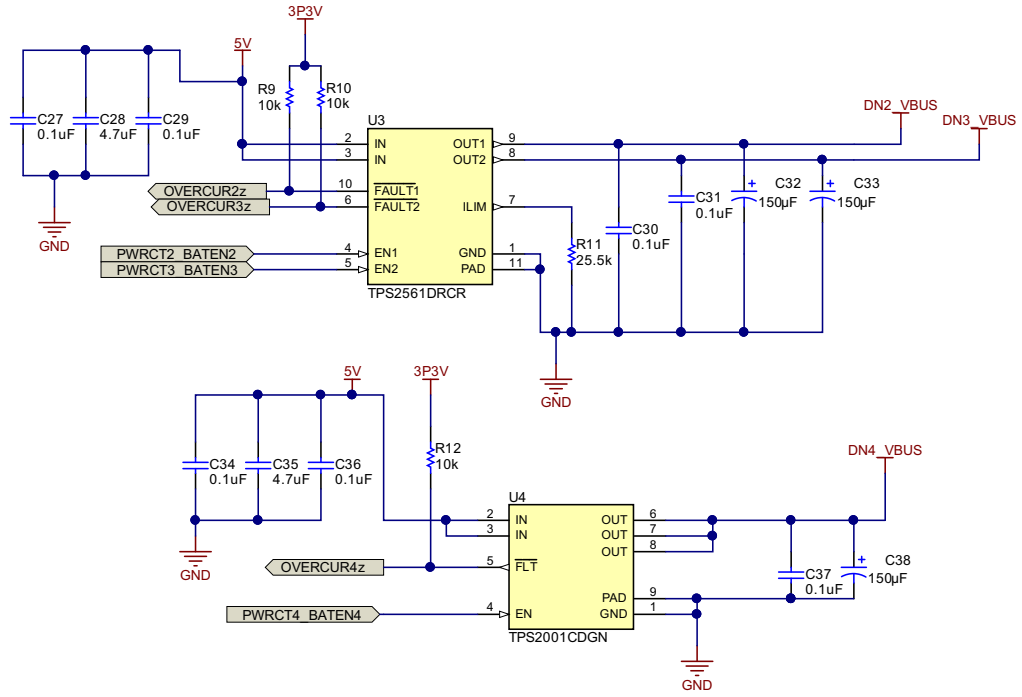


Figure 41. VBUS Power Switch Implementation

9.2.1.2.7 PD Controller and EEPROM Implementation

In this specfic application, PD controller monitors and controls the CC line and the VBUS on both the upstream Type-C port and the downstream Type-C port. It also utilizes BBconfigure0 and BBconfigure1 to set up the billboard function of TUSB8044 and custom billboard information is stored in the EEPROM. Moreover, the controller uses the GPIOs to control the super speed MUX.

The TUSB8044 loads the 256 bytes plus the billboard strings from an external EEPROM. The billboard string starts at address 0x100 and ends at address 0x2DF for a total of 480 bytes. A minimum of 5.888Kbit EEPROM is recommended. EEPROMs do not come in this size so an 8Kbit EEPROM (10-bit addressing) is recommended. For example, an Atmel AT24C08A could be used.

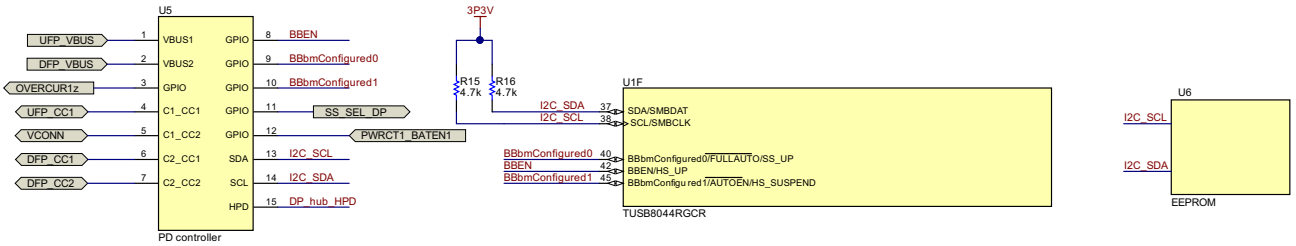


Figure 42. PD Controller and EEPROM Implementation

9.2.1.2.8 DisplayPort Implementation

The DisplayPort interface can be implemented with a DisplayPort MST Hub or a DisplayPort redriver/retimer. The main channels and the AUX channels are connected to the DP receptacle after the HUB.

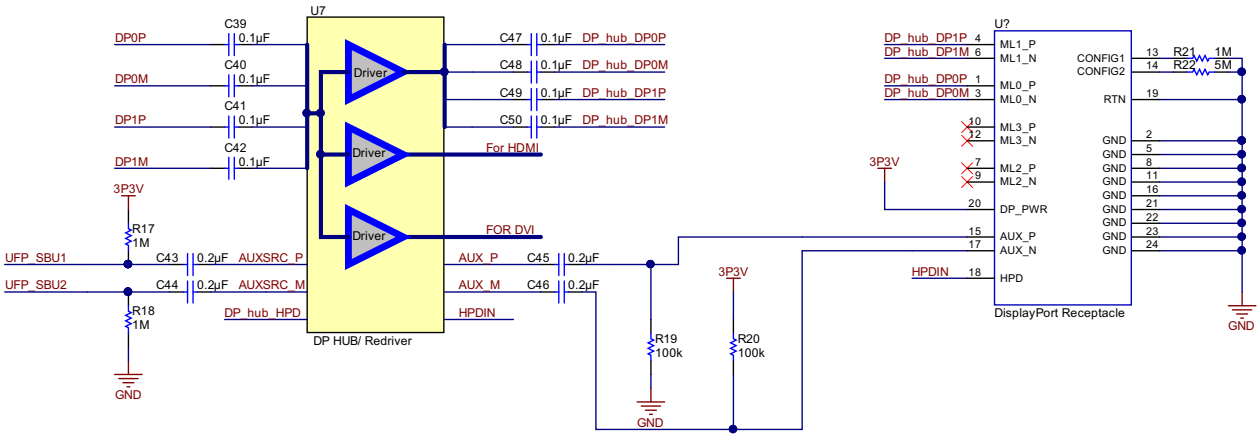


Figure 43. DisplayPort Implementation

9.2.1.2.9 Clock, Reset, and Misc

The PWRCTL_POL is left unconnected which results in active high power enable (PWRCTL1, PWRCTL2, PWRCTL3, and PWRCTL4) for a USB VBUS power switch. SMBUSz pin is also left unconnected which will select I2C mode. Both PWRCTL_POL and SMBUSz pins have internal pull-ups. The 1 µF capacitor on the GRSTN pin can only be used if the VDD11 supply is stable before the VDD33 supply. The depending on the supply ramp of the two supplies the capacitor size may have to be adjusted.

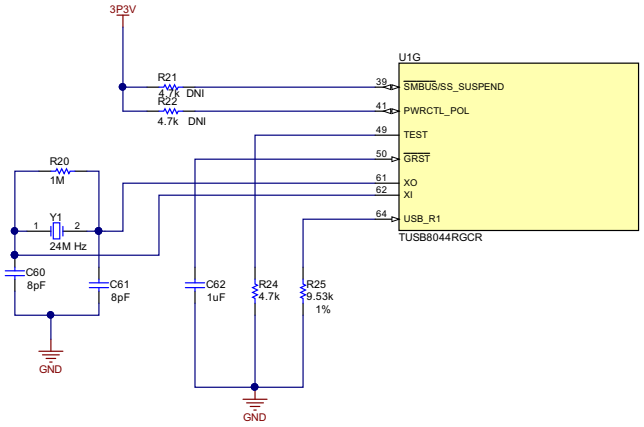


Figure 44. Clock, Reset, and Misc

9.2.1.2.10 TUSB8044 Power Implementation

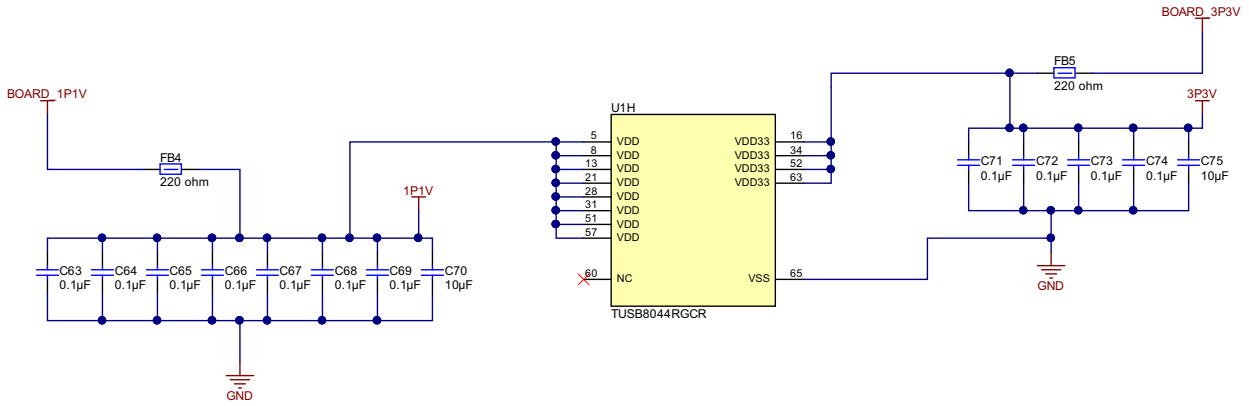


Figure 45. TUSB8044 Power Implementation

9.2.1.3 Application Curves

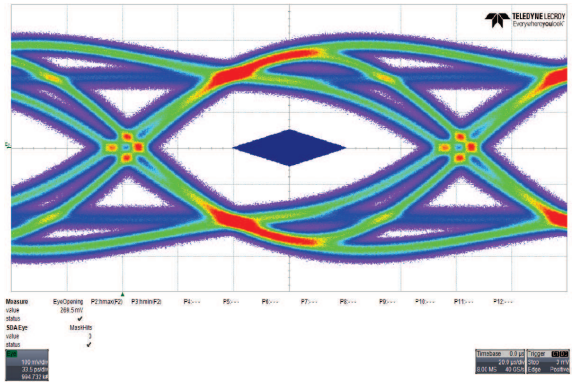


Figure 46. Upstream Port

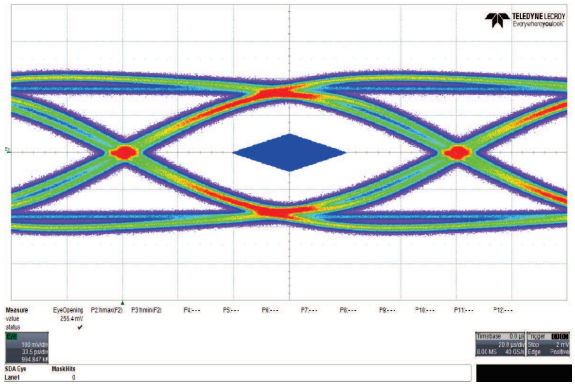


Figure 47. Downstream Port 1

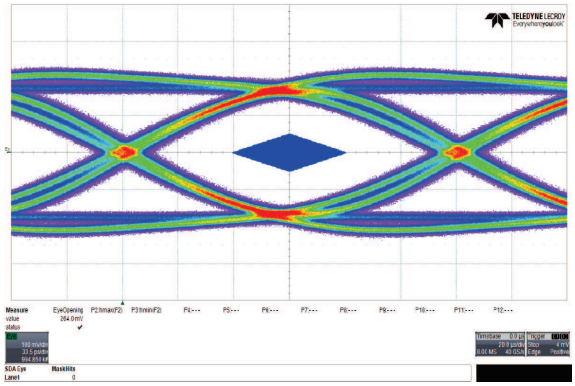


Figure 48. Downstream Port 2

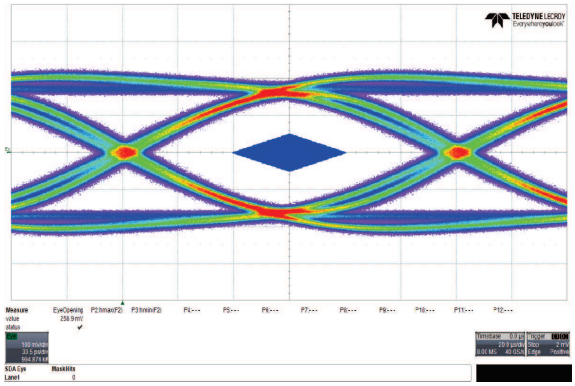


Figure 49. Downstream Port 3

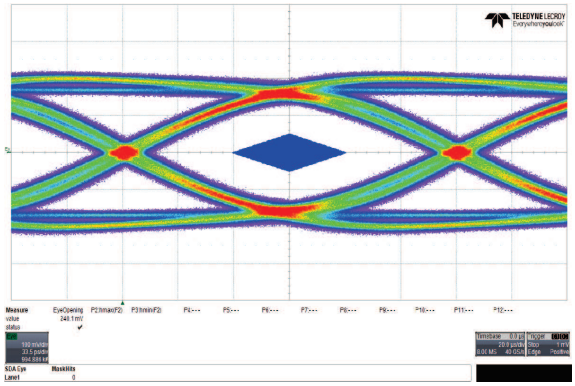


Figure 50. Downstream Port 4

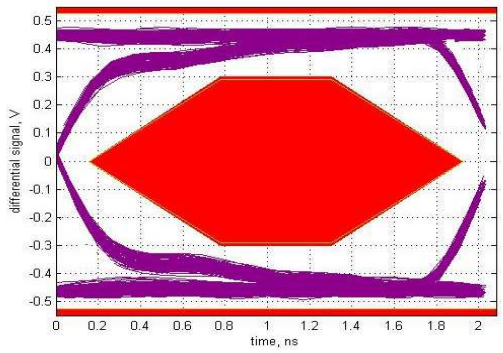


Figure 51. High-Speed Upstream Port

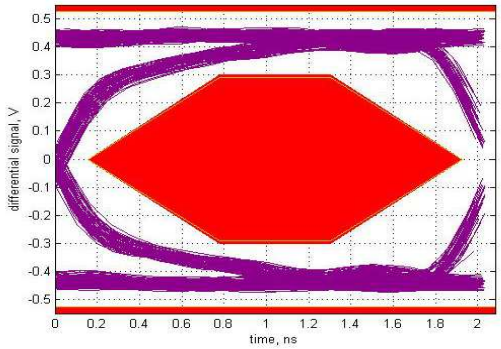


Figure 52. High-Speed Downstream Port 1

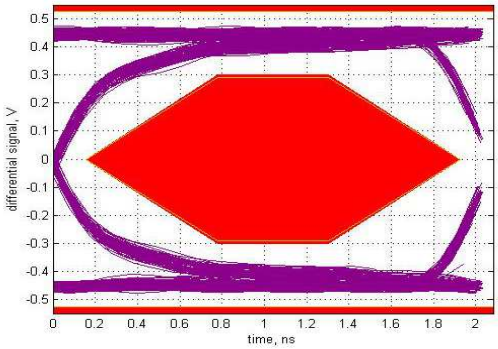


Figure 53. High-Speed Downstream Port 2

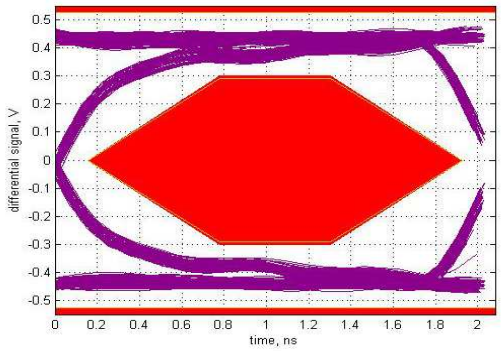


Figure 54. High-Speed Downstream Port 3

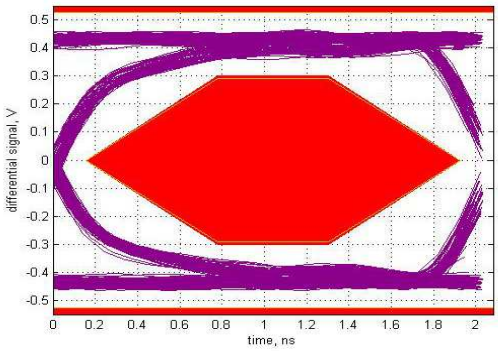


Figure 55. High-Speed Downstream Port 4

10 Power Supply Recommendations

10.1 TUSB8044 Power Supply

V_{DD} should be implemented as a single power plane, as should V_{DD33}.

- The V_{DD} pins of the TUSB8044 supply 1.1 V (nominal) power to the core of the TUSB8044. This power rail can be isolated from all other power rails by a ferrite bead to reduce noise.
- The DC resistance of the ferrite bead on the core power rail can affect the voltage provided to the device due to the high current draw on the power rail. The output of the core voltage regulator may need to be adjusted to account for this or a ferrite bead with low DC resistance (less than 0.05 Ω) can be selected.
- The V_{DD33} pins of the TUSB8044 supply 3.3 V power rail to the I/O of the TUSB8044. This power rail can be isolated from all other power rails by a ferrite bead to reduce noise.
- All power rails require a 10 µF capacitor or 1 µF capacitors for stability and noise immunity. These bulk capacitors can be placed anywhere on the power rail. The smaller decoupling capacitors should be placed as close to the TUSB8044 power pins as possible with an optimal grouping of two of differing values per pin.

10.2 Downstream Port Power

- The downstream port power, VBUS, must be supplied by a source capable of supplying 5V and up to 900 mA per port. Downstream port power switches can be controlled by the TUSB8044 signals. It is also possible to leave the downstream port power always enabled.
- A large bulk low-ESR capacitor of 22 µF or larger is required on each downstream port's VBUS to limit in-rush current.
- The ferrite beads on the VBUS pins of the downstream USB port connections are recommended for both ESD and EMI reasons. A 0.1µF capacitor on the USB connector side of the ferrite provides a low impedance path to ground for fast rise time ESD current that might have coupled onto the VBUS trace from the cable.

10.3 Ground

It is recommended that only one board ground plane be used in the design. This provides the best image plane for signal traces running above the plane. The thermal pad of the TUSB8044 and any of the voltage regulators should be connected to this plane with vias. An earth or chassis ground is implemented only near the USB port connectors on a different plane for EMI and ESD purposes.

11 Layout

11.1 Layout Guidelines

11.1.1 Placement

1. 9.53K +/-1% resistor connected to pin USB_R1 should be placed as close as possible to the TUSB8044.
2. A 0.1 µF should be placed as close as possible on each VDD and VDD33 power pin.
3. The 100 nF capacitors on the SSTXP and SSTXM nets should be placed close to the USB connector (Type A, Type B, and so forth).
4. The ESD and EMI protection devices (if used) should also be placed as close as possible to the USB connector.
5. If a crystal is used, it must be placed as close as possible to the TUSB8044 XI and XO pins.
6. Place voltage regulators as far away as possible from the TUSB8044, the crystal, and the differential pairs.
7. In general, the large bulk capacitors associated with each power rail should be placed as close as possible to the voltage regulators.

11.1.2 Package Specific

1. The TUSB8044 package has a 0.5-mm pin pitch.
2. The TUSB8044 package has a 6.0-mm x 6.0-mm thermal pad. This thermal pad must be connected to ground through a system of vias.
3. All vias under device, except for those connected to thermal pad, should be solder masked to avoid any potential issues with thermal pad layouts.

11.1.3 Differential Pairs

This section describes the layout recommendations for all the TUSB8044 differential pairs: USB_DP_XX, USB_DM_XX, USB_SSTXP_XX, USB_SSTXM_XX, USB_SSRXP_XX, and USB_SSRXM_XX.

1. Must be designed with a differential impedance of 90 Ω ±10%.
2. In order to minimize cross talk, it is recommended to keep high speed signals away from each other. Each pair should be separated by at least 5 times the signal trace width. Separating with ground as depicted in the layout example will also help minimize cross talk.
3. Route all differential pairs on the same layer adjacent to a solid ground plane.
4. Do not route differential pairs over any plane split.
5. Adding test points will cause impedance discontinuity and will therefore negative impact signal performance. If test points are used, they should be placed in series and symmetrically. They must not be placed in a manner that causes stub on the differential pair.
6. Avoid 90 degree turns in trace. The use of bends in differential traces should be kept to a minimum. When bends are used, the number of left and right bends should be as equal as possible and the angle of the bend should be ≥ 135 degrees. This will minimize any length mismatch causes by the bends and therefore minimize the impact bends have on EMI.
7. Minimize the trace lengths of the differential pair traces. The maximum recommended trace length for SS differential pair signals and USB 2.0 differential pair signals is eight inches. Longer trace lengths require very careful routing to assure proper signal integrity.
8. Match the etch lengths of the differential pair traces (i.e. DP and DM or SSRXP and SSRXM or SSTXP and SSTXM). There should be less than 5 mils difference between a SS differential pair signal and its complement. The USB 2.0 differential pairs should not exceed 50 mils relative trace length difference.
9. The etch lengths of the differential pair groups do not need to match (i.e. the length of the SSRX pair to that of the SSTX pair), but all trace lengths should be minimized.
10. Minimize the use of vias in the differential pair paths as much as possible. If this is not practical, make sure that the same via type and placement are used for both signals in a pair. Any vias used should be placed as close as possible to the TUSB8044 device.
11. To ease routing, the polarity of the SS differential pairs can be swapped. This means that SSTXP can be routed to SSTXM or SSRXM can be routed to SSRXP.

Layout Guidelines (continued)

12. To ease routing of the USB2 DP and DM pair, the polarity of these pins can be swapped. If this is done, the appropriate Px_usb2pol register, where x = 0, 1, 2, 3, or 4, must be set.
13. Do not place power fuses across the differential pair traces.

11.2 Layout Examples

11.2.1 Upstream Port

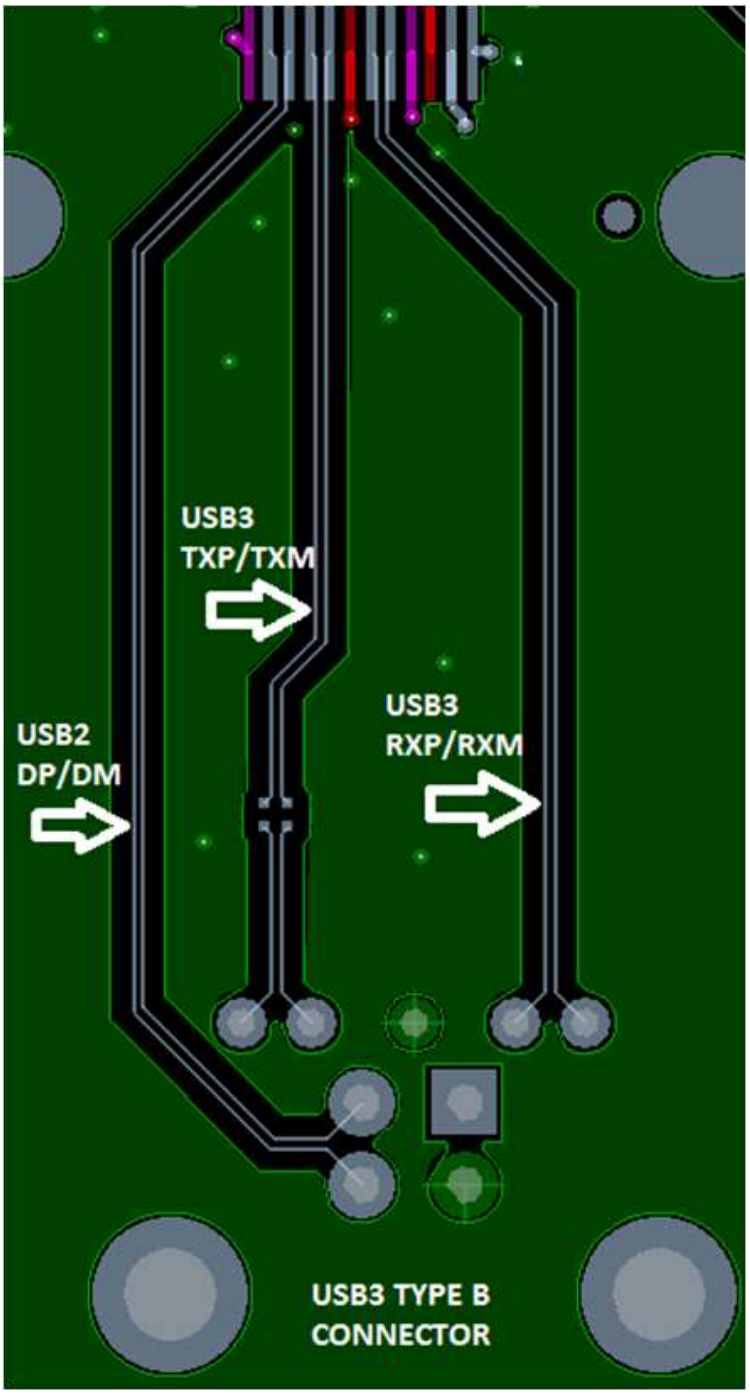


Figure 56. Example Routing of Upstream Port

Layout Examples (continued)

11.2.2 Downstream Port

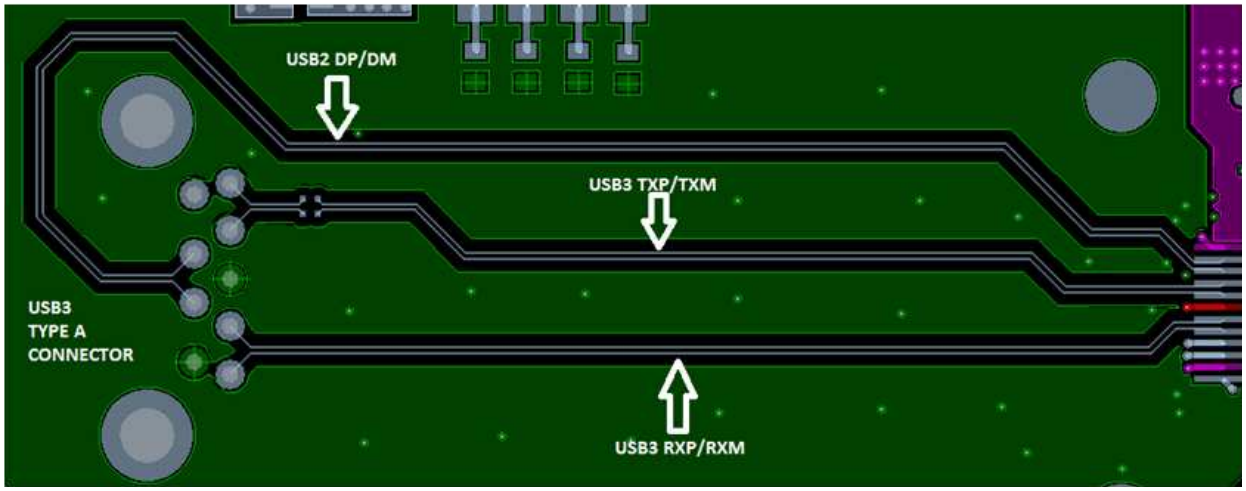


Figure 57. Example Routing of Downstream Port

The remaining three downstream ports routing can be similar to the example provided.

12 デバイスおよびドキュメントのサポート

12.1 ドキュメントの更新通知を受け取る方法

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12.2 コミュニティ・リソース

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12.5 Glossary

SLYZ022 — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

13 メカニカル、パッケージ、および注文情報

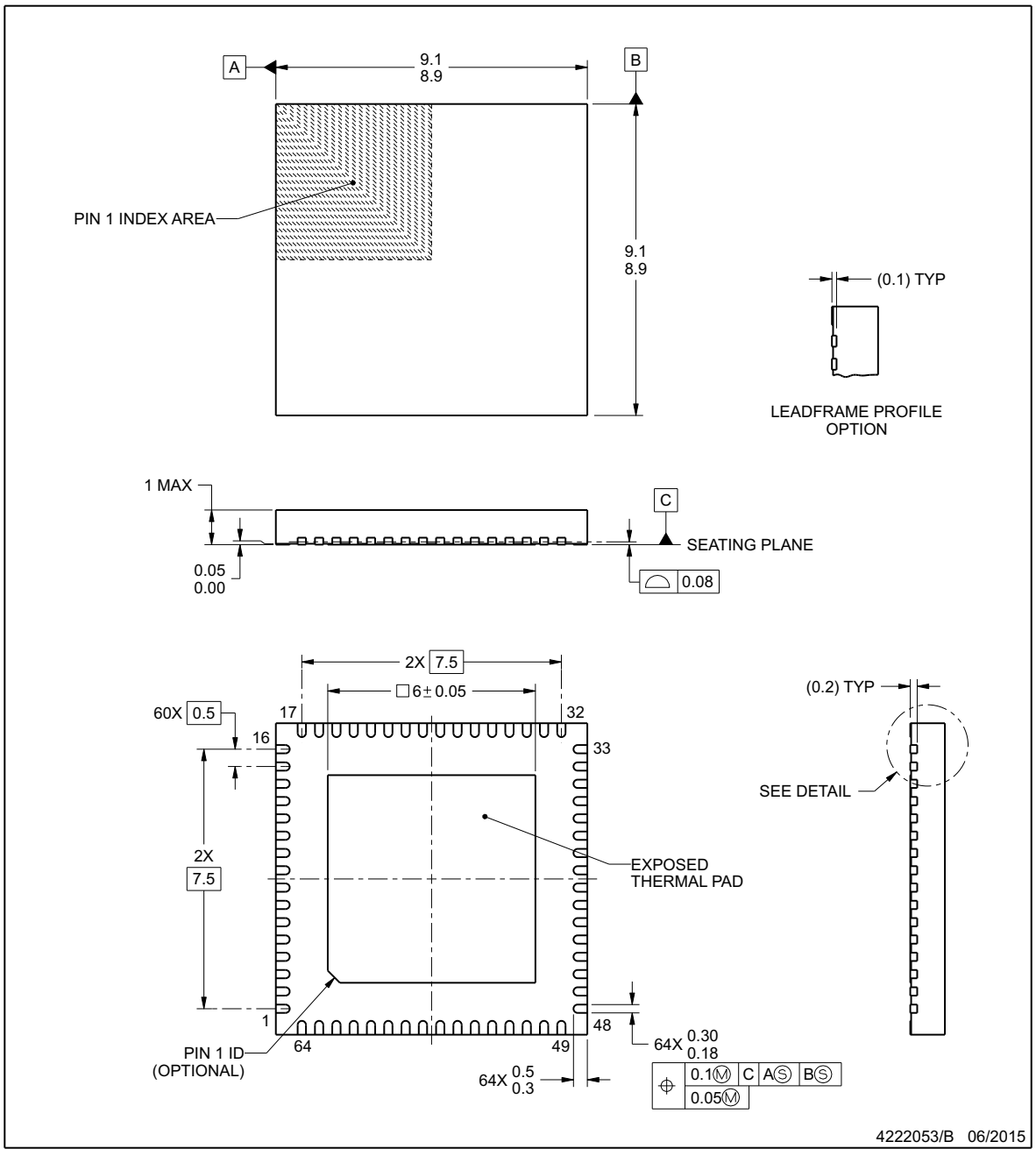
以降のページには、メカニカル、パッケージ、および注文に関する情報が記載されています。これらの情報は、指定のデバイスに対して提供されている最新のデータです。このデータは予告なく変更されることがあり、ドキュメントが改訂される場合もあります。本データシートのブラウザ版を使用されている場合は、画面左側の説明をご覧ください。

PACKAGE OUTLINE

RGC0064G

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



NOTES:

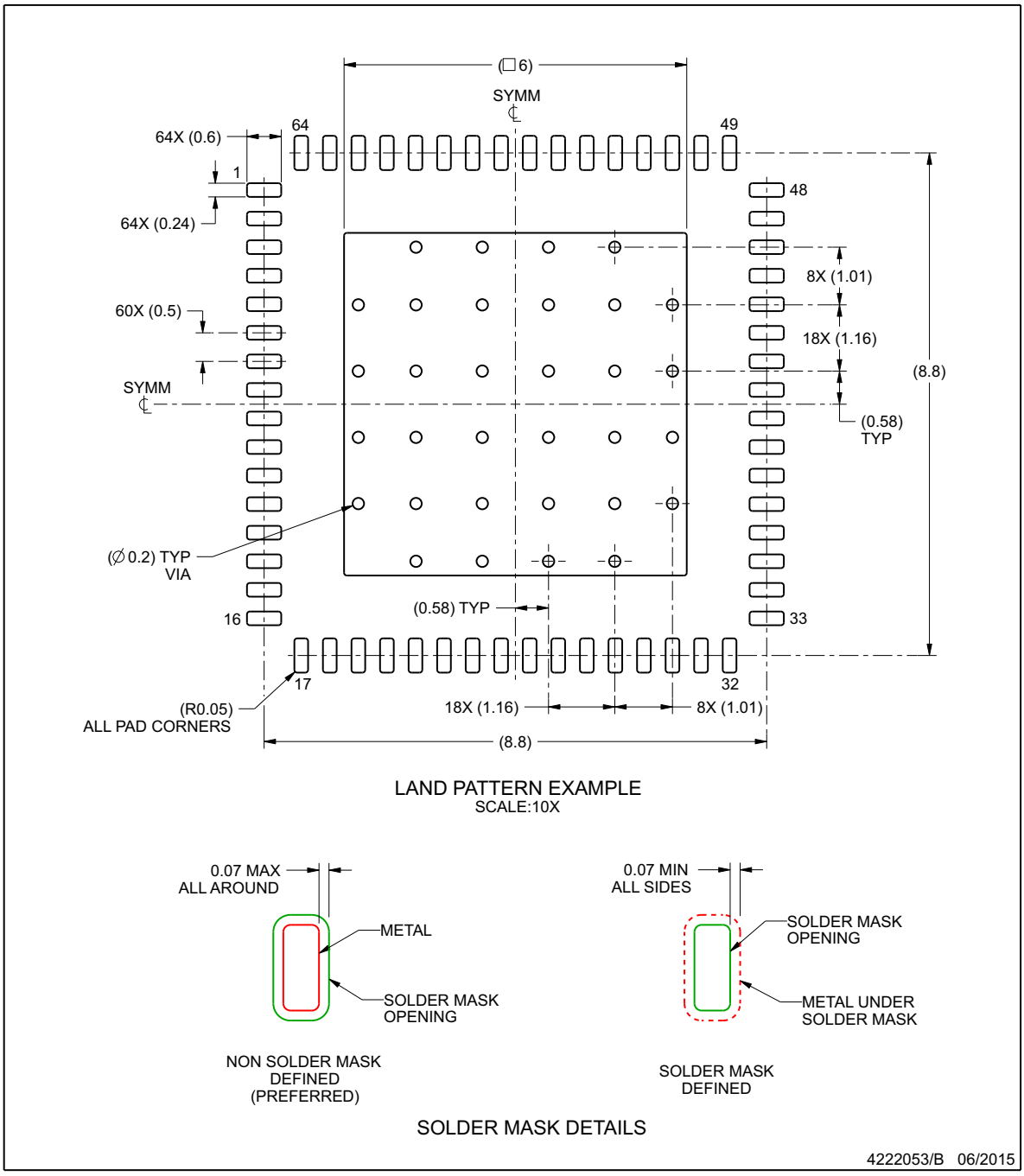
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

EXAMPLE BOARD LAYOUT

RGC0064G

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



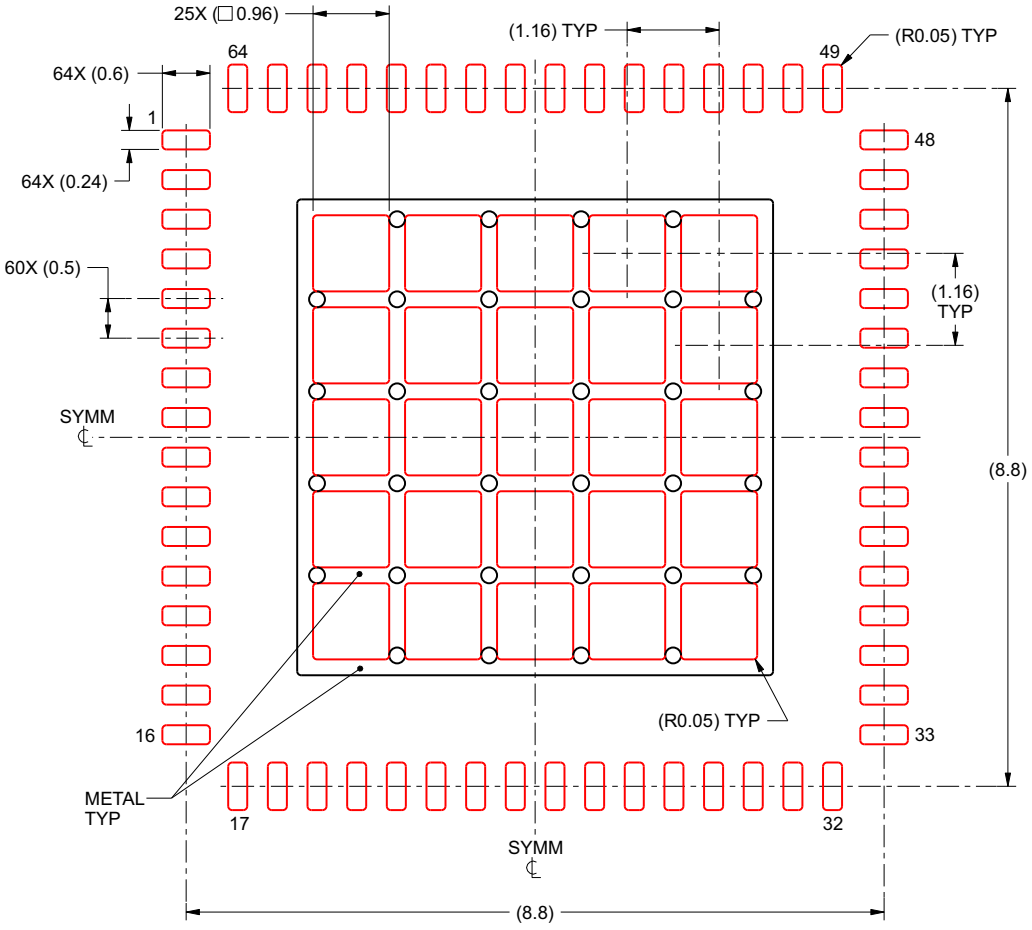
NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

EXAMPLE STENCIL DESIGN

RGC0064G — **VQFN - 1 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD
64% PRINTED SOLDER COVERAGE BY AREA
SCALE:12X

4222053/B 06/2015

NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TUSB8044RGCR	NRND	VQFN	RGC	64	2000	RoHS & Green	NIPDAU	Level-3-260C-168 HR	0 to 70	TUSB8044	
TUSB8044RGCT	NRND	VQFN	RGC	64	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	0 to 70	TUSB8044	

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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